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Raydium Semiconductor Corporation

RM69090 Data Sheet

Single Chip Driver with 16.7M color

for 480RGBx480 OLED driver

Revision：0.1

Date：Mar, 22 2019

Revision History

Version No.	Date	Description	Page	Modified By	Checked By
0.1	2019/03/22	First Release		Howard Hsiung	CN.Lin

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1. General Description

The RM69090 device is a single-chip solution for LTPS AMOLED that incorporates gate drivers and is capable of 480RGBx480, 400RGBx400, 360RGBx480, 320RGBx320, 320RGBx480, 272RGBx480, 240RGBx240, 240RGBx320, 180RGBx360, 180RGBx540, 128RGBx432with internal GRAM. It includes a 2,764,800 bits internal memory, a timing controller with glass interface level-shifters and a glass power supply circuit.

The RM69090 supports MIPI Interface, 8-bit system interfaces, serial peripheral interfaces (SPI), dual serial peripheral interfaces (Dual-SPI). The specified window area can be updated selectively, so that moving pictures can be displayed simultaneously independent of the still picture area.

The RM69090 is also able to make gamma correction settings separately for RGB dots to allow benign adjustments to panel characteristics, resulting in higher display qualities. The IC possesses internal GRAM that stores 480 x 480 x 1/2 x 24 bits for 16.77M-color images.   A deep standby mode is also supported for lower power consumption.

This LSI is suitable for wearable device applications, including I-watch and smart band.

2. Features

■ **Single chip AMOLED controller/driver with display RAM**

■ **Display resolution option**

  ➢ 480RGB x 480

  ➢ 400RGB x 400

  ➢ 360RGB x 480

  ➢ 320RGB x 320

  ➢ 320RGB x 480

  ➢ 272RGB x 480

  ➢ 240RGB x 240

  ➢ 240RGB x 320

  ➢ 180RGB x 360

  ➢ 180RGB x 540

  ➢ 128RGB x 432

■ **Display data RAM (frame memory): 2,764,800 bits**

■ **Display mode (Color mode)**

  ➢ Normal mode: 16.7M-colors, 4096-colors, 8-colors

  ➢ Idle mode: 16.7M-colors, 4096-colors, 8-colors

■ **Interface**

  ➢ 8-bits 80-series MPU interface

  ➢ Serial peripheral interface (SPI)

  ➢ Dual serial peripheral interface (Dual-SPI)

  ➢ MIPI Display Serial Interface (1 clock and 2 data lane pairs)

    ◆ Support 1lane/2lane (1lane: 500Mbps)

    ◆ Maximum total bit rate is 500Mbps of 2 data lanes 24-bit data format/ 360Mbps of 2 data lanes 18-bit data format/ 320Mbps of 2 data lanes 16-bit data format

■ **Interface pixel format**

  ➢ MIPI: RGB888/ RGB666/ RGB565

  ➢ SPI: RGB888/ RGB666/ RGB565/ RGB332/ RGB111/ Gray 256.

■ **Abundant color display and drawing functions**

  ➢ Programmable γ-correction function for 16.7 million color display

  ➢ Individual gamma correction setting for RGB dots

  ➢ Partial display function

■ **Sunlight readable**

■ **Control power IC by one-wire interface**

■ **On chip**

  ➢ VREFP5/VREFN5 voltage generator for panel voltage

  ➢ VGHR/VGLR voltage for gate control signal

  ➢ Internal oscillator for display clock

  ➢ Source output MUX 1-6 with 240ch source output pins

  ➢ Supports gate control signals to gate driver in the panel

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- ■ **Built-in OTP function to adjust panel setting**
- ■ **Logic / interface power supply voltage VDDI = 1.65V ~ 3.3V**
- ■ **Analog power supply voltage VDD = 2.7V ~ 3.6V**
- ■ **Output voltage levels**
  - ➢ Positive gate driver voltage range for VGHR: 3 ~ 10.5V   (Max<=VGH-0.3v)
  - ➢ Negative gate driver voltage range for VGLR: -2V ~ -9.5V   (Min>=VGL+0.3v)
  - ➢ VREFP5 panel voltage range : 0~5V   (Max<=AVDD-0.3v)
  - ➢ VREFN5 panel voltage range : -0.5~-4.5V (Min>=VCL+0.3v)
  - ➢ Step-up 1,2 output voltage range for AVDD: 4.5 ~ 6.5V, VCL: -3.5 ~ -5.0V
  - ➢ Gamma high/low voltage range for VGMP: 2.0V ~ 6.0V (Max<=AVDD-0.5v) , VGSP: 0V, 0.2125V ~ 4.5V
- ■ **Package: COF/COG**
- ■ **Chip size evaluation : 8300um x 2060um(including scribe line)**

■ **Power Supply Specifications**

No.	Item		Description
1	Source Driver		240 pins (480 x RGB)
2	gate control timing Level shift		VGHR-VGLR
3	Input Voltage	VDDI	1.65 ~ 3.3V
		VCC	Connect to VDDI or VDD(VCI)
		VDD (VDDA/VDDB/VDDR)	2.70 ~ 3.60V
4	OLED drive voltages	AVDD	4.5V ~ 6.5V
		VGHR	3V ~ 10.5V (Max<=VGH-0.3v)
		VGLR	-2V ~ -9.5V (Min>=VGL+0.3v)
		VREFP5	0V ~ 5V (Max<=AVDD-0.3v)
		VREFN5	-0.5V ~ -4.5V (Min>=VCL+0.3v)
5	Internal step-up circuits	AVDD	VCI x2.0(dual), x3.0(single)
		VCL	VCI x -1.0(dual), x-2.0(single)
		VGH	VCI x2, x3, x4
		VGL	VCI x-2, x-3, x-4

3. Block Diagram
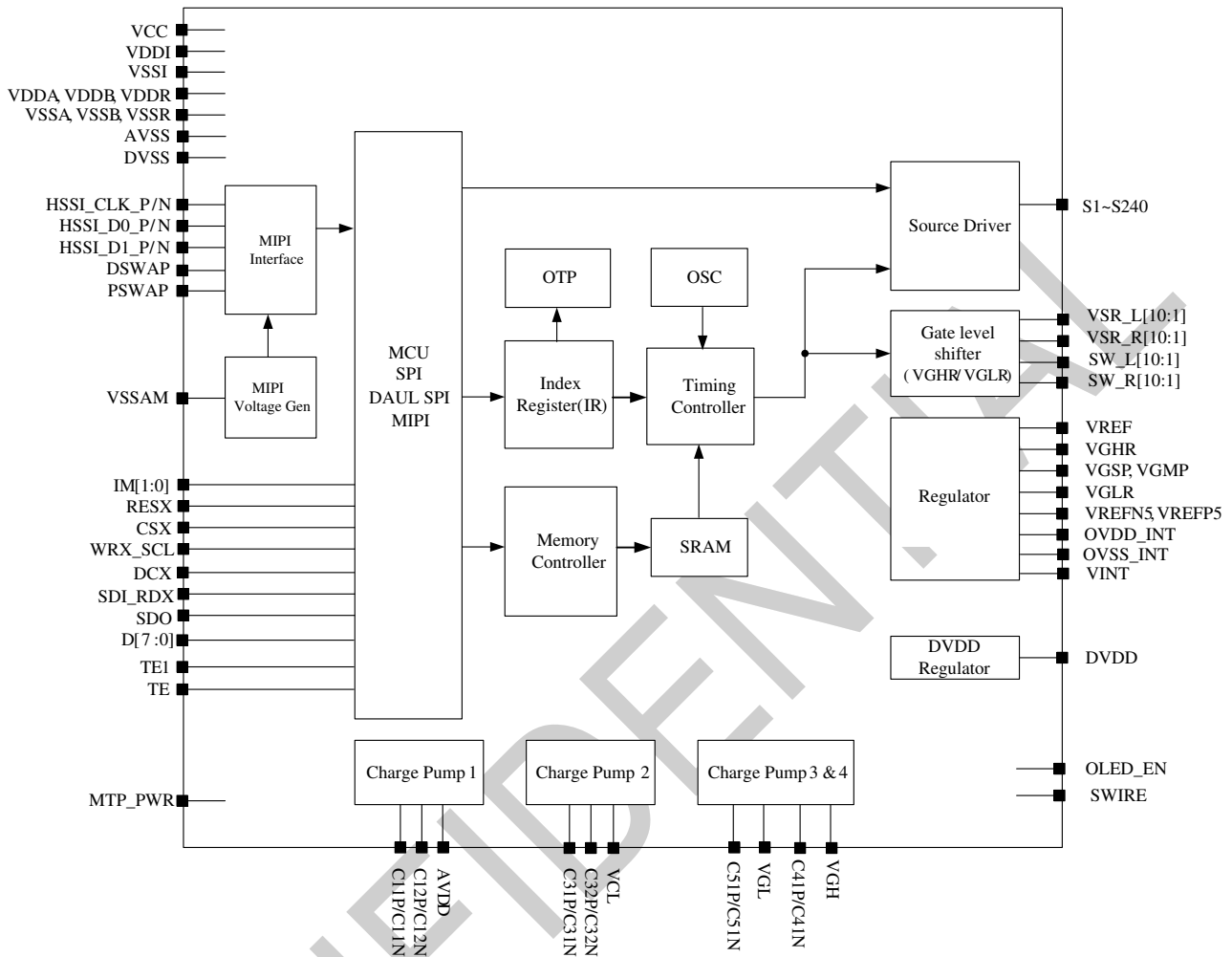
Interface

The RM69090 supports MIPI DSI interface. MIPI DSI can access both internal command and display data.

Grayscale Voltage Generating Circuit
Grayscale voltage generating circuit generates a drive voltage, which corresponds to grayscale level set in the γ correction register. The RM69090 displays 16.7M colors at the maximum.

Power Supply Circuit
The power supply circuit generates supply voltages to OLED panel, VGH, VGL.

Timing Generating
The timing controller generates timing signals for internal circuits such as the display timing.

Oscillator
The RM69090 incorporates RC oscillator circuit. The frame frequency is changeable by command settings.

Panel Driver Circuit

The OLED display driver circuit consists of 240 source drivers (S1~S240). The gate signal consists of VSR_R/L[1:10], SW_R/L[1:10] and outputs either VGHR or VGLR level.

4. Pin Description

4.1 Power Supply Pins

Signal	I/O	Function
VDDB	P	Power supply for DC/DC converter VDDB, VDDA and VDDR should be the same input voltage level
VDDA	P	Power supply for analog system. VDDB, VDDA and VDDR should be the same input voltage level
VDDR	P	Power supply for regulator system VDDB, VDDA and VDDR should be the same input voltage level
VDDI	P	Power supply for interface system except MIPI interface.
VCC	P	Power supply for DVDD regulator
VSSB	P	System ground for DC/DC converter
VSSA	P	System ground for analog system
VSSR	P	System ground for regulator system
VSSAM	P	System ground for internal MIPI analog system
VSSI	P	System ground for interface system except MIPI interface
DVSS	P	System ground for internal digital system
AVSS	P	System ground for source OP system.
MTP_PWR	P	MTP programming power supply pin (7.5V typical) Must be left open or connected to DVSS in normal condition.

4.2 Interface Pins

Signal	I/O	Function
CSX	I	Chip select input pin ("Low" enable) in 80-series MPU I/F and SPI I/F. If not used, please connect to VDDI.
WRX_SCL	I	WRX : Writes strobe signal to write data when WRX is "Low" in 80-series MPU I/F. SCL: A synchronous clock signal in SPI I/F. If not used, please connect to VSSI.
D/CX	I	Display data / command selection in 80-series MPU I/F and 4-wire SPI I/F. D/CX = "0" : Command D/CX = "1" : Display data or Parameter If not used, please connect to VSSI.
SDI_RDX	I/O	SDI: Serial input signal in SPI I/F. The data is input on the rising edge of the SCL signal. RDX : Reads strobe signal to write data when RDX is "Low" in 80-series MPU interface. If not used, please leave it Open.
SDO	O	Serial output signal in SPI I/F. The data is output on the rising/falling edge of the SCL signal. If the host places the SDI line into high-impedance state during the read interval, the SDI and SDO can be tied together. If not used, please open this pin.
D[7:0]	I/O	8-bit bi-directional data bus for 80-series MPU I/F and 8-bit input data bus for RGB I/F. These pins are not used for SPI, MIPI, please leave it Open.

4.3 MIPI Interface Pins

Signal	I/O	Function
HSSI_CLK_P HSSI_CLK_N	I	-These pins are DSI-CLK+/- differential clock signals if MIPI interface is used. -If not used, please connect these pins to VSSAM.
HSSI_D0_P HSSI_D0_N	I/O	-These pins are DSI-D0+/- differential data signals if MIPI interface is used. -If not used, please connect these pins to VSSAM.
HSSI_D1_P HSSI_D1_N	I/O	-These pins are DSI-D1+/- differential data signals if MIPI interface is used. -If not used, please connect these pins to VSSAM.
DSWAP PSWAP	I	Input pin to select HSSI_D0/D1 data lane sequence and polarity in high speed interface only. See table below. If not used, please connect to VSSI.

Input pin to select HSSI_D0/D1 data lane sequence and polarity in high speed interface only.

Pin Name	HSSI_D0_P	HSSI_D0_N	HSSI_CLK_P	HSSI_CLK_N	HSSI_D1_P	HSSI_D1_N
DSWAP=0 PSWAP=0	DSI D0+	DSI D0-	DSI CLK+	DSI CLK-	DSI D1+	DSI D1-
DSWAP=0 PSWAP=1	DSI D0-	DSI D0+	DSI CLK-	DSI CLK+	DSI D1-	DSI D1+
DSWAP=1 PSWAP=0	DSI D1+	DSI D1-	DSI CLK+	DSI CLK-	DSI D0+	DSI D0-
DSWAP=1 PSWAP=1	DSI D1-	DSI D1+	DSI CLK-	DSI CLK+	DSI D0-	DSI D0+

If not used, please connect to VSSI.

NOTE: "1" = VDDI level, "0" = VSSI level.

4.4 Interface Logic Pins

Signal	I/O	Function
RESX	I	This signal will reset the device and must be applied to properly initialize the chip. Signal is active low.
IM[1:0]	I	Interface type selection. The connections of IM[1:0] which not shown in table are invalid. | IM[1:0]	Display Data	Command
---	---	---
00	MIPI / 3-wire SPI	MIPI / 3-wire SPI
01	MIPI / 4-wire SPI	MIPI / 4-wire SPI
10	MIPI / QAD-SPI	MIPI / QAD-SPI
11	MCU 8-bit	MCU 8-bit	
BSTM	I	Boost mode selection pin. 	BSTM	Mode
---	---
0	2 PWR(VDDI, VCI) AVDD --> internal CP VCL --> internal CP
1	Reserved	
TE	O	Tearing effect output pin to synchronize MCU to frame writing, activated by S/W command. When this pin is not activated, this pin is output low.
TE1	O	If not used, please open this pin.
SWIRE	O	Swire protocol setting pin of Power IC, If not used, please open this pin.
OLED_EN	O	Power IC enable control pin, If not used, please open this pin.

NOTE: "1" = VDDI level, "0" = VSSI level.

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4.5 Driver Output Pins (Pins for Panel)

Signal	I/O	Function
S1 ~ S240	O	Pixel electrode driving output.
SDMY[1] ~ SDMY[21]	O	Dummy Source, leave it Open.
VSR_L[10:1] VSR_R[10:1]	O	VSR control signals, Level shift output, (VGHR-VGLR)
SW_L[10:1] SW_R[10:1]	O	VSR control signals, Level shift output, (VGHR-VGLR)

4.6 DC/DC Convert Pins

Signal	I/O	Function
AVDD	O	Output voltage from step-up circuit 1, generated from VDDB. Connect a capacitor for stabilization.
VCL	O	Output voltage from step-up circuit 3, generated from VDDB. Connect a capacitor for stabilization.
VGH	O	Output voltage from step-up circuit 4. Connect a capacitor for stabilization.
VGL	O	Output voltage from step-up circuit 5. Connect a capacitor for stabilization.
C11P, C11N C12P, C12N	IO	Capacitor connection pins for the step-up circuit which generate AVDD. Connect capacitor as requirement. When not in used, please open these pins.
C31P, C31N C32P, C32N	IO	Capacitor connection pins for the step-up circuit which generate VCL. Connect capacitor as requirement.
C41P, C41N	IO	Capacitor connection pins for the step-up circuit which generate VGH. Connect capacitor as requirement.
C51P, C51N	IO	Capacitor connection pins for the step-up circuit which generate VGL. Connect capacitor as requirement.
VGHR	O	Output voltage generated from VGH. LDO output used for panel voltage. Connect a capacitor for stabilization. When not in use, please open this pin.
VGLR	O	Output voltage generated from VGL. LDO output used for panel voltage. Connect a capacitor for stabilization. When not in use, please open this pin.
VGMP	O	Output voltage generated from AVDD. LDO output for positive gamma high voltage generator.
VGSP	O	Output voltage generated from AVDD. LDO output for positive gamma low voltage generator.
VREF	O	Regulator output for internal reference voltage. Connect capacitor for stabilization.
DVDD	O	Regulator output for logic system power. Connect a capacitor for stabilization.
VREFP5	O	Regulator output for VREFP(0~5V)
VREFN5	O	Regulator output for VREFP(-0.5~-5V)
VINT	O	Connect a capacitor for stabilization.

4.7 Test Pins

Signal	I/O	Function
ANALOG_TEST 1~2	O	Test pin, not accessible to user. Must be left open.
TEST1~3	IO	Test pin, not accessible to user. Must be left open.
TESTEN	I	Test pin, not accessible to user. Must be left open., Internal pull low
EXTCLK	I	Test pin, not accessible to user. Must be left open.
DUMMY	I	Dummy PAD, leave it open

5. Function Description

5.1 Interface Type Selection

Interface type selection. The connections of IM[1:0] which not shown in table are invalid.

IM[1:0]	Display Data	Command
00	MIPI / 3-wire SPI	MIPI / 3-wire SPI
01	MIPI / 4-wire SPI	MIPI / 4-wire SPI
10	MIPI / QAD-SPI	MIPI / QAD-SPI
11	MCU 8-bit	MCU 8-bit

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5.2 Three-wire/four-wire SPI Interface

5.2.1 Write Cycle and Sequence

During a write cycle, the host processor sends a series bit string of either command or display data to the display module via the interface. The 3-wire SPI utilizes CSX, SCL, and SDA for data transmission. As to 4-wire SPI, DCX is a must for the host to indicate whether the input information is data/parameter or command.

The write sequence is initiated when CSX is driven from high to low and ends when CSX is pulled high. SCL is driven from high to low then pulled back to high during the write cycle for the data latch. Therefore, the host must transmit valid information on the rising edge of SCL with enough setup time and hold time. DCX is driven low while command is input and pulled to high while input information are data/parameter. The 3-wire/4-wire SPI interface write command sequences are illustrated in the following figures.
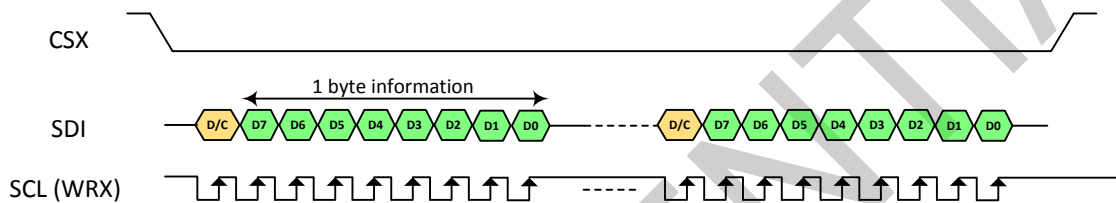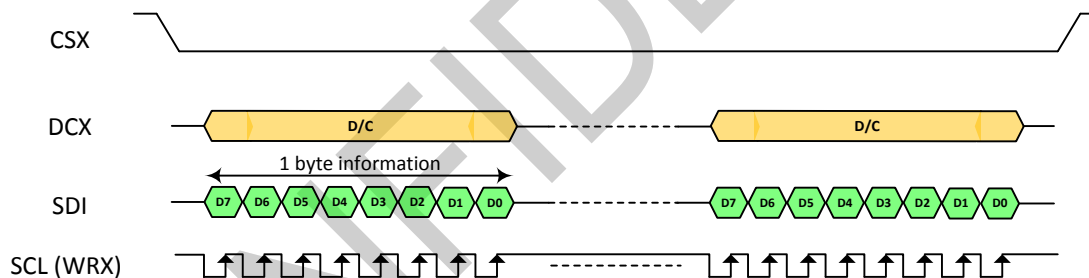
5.2.2 Read Cycle and Sequence

During a read cycle, the host reads a single bit of data from the display module via the interface. The 3-wire/4-wire SPI interface utilizes CSX, SCL and SDA for data transmission. SCL is driven from high to low then pulled back to high during the read cycle. The display module provides readout information during the read cycle while the host reads the display module information back on the rising edge of SCL. The read sequence is initiated when CSX is driven from high to low and ends when CSX is pulled high. The 3-wire/4-wire SPI interface read command sequences are described in the following figure.

There is one restriction for the read operation of this interface, and that is, not all data can be readout. Only the data with the following address in the DCS can be read, and they are 0Ah, 0Bh, 0Ch, 0Dh, 0Eh, 0Fh, DAh, DBh, DCh, 52h, 54h, 59h, 64h, AAh, AFh, DAh, DBh, DCh, E1h, E2h, and E3h. An extra dummy clock as depicted in the following is necessary for those multi-parameter addresses such as 04h, 45h, A1h, and A8h.
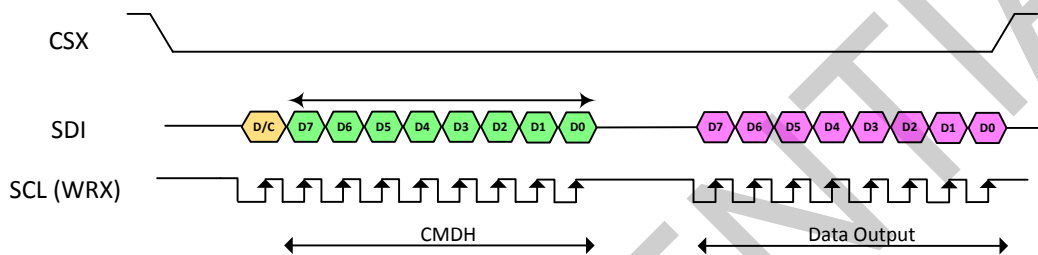
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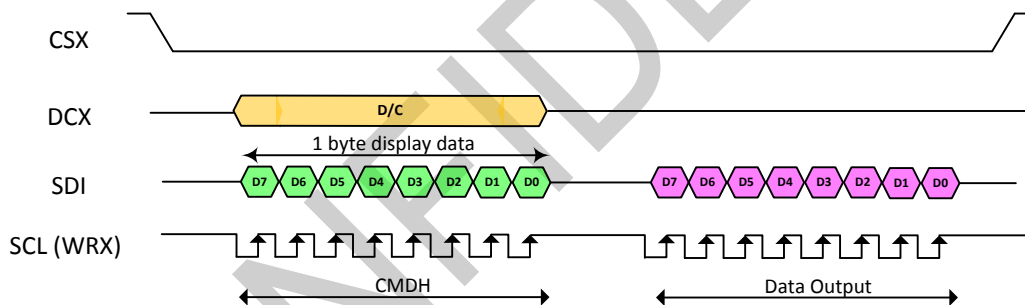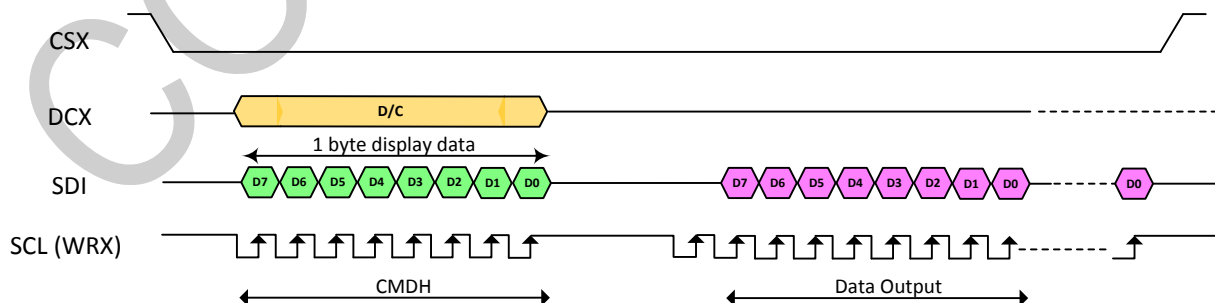
5.2.3 Break and Pause Sequence

The host processor can break a read or write sequence by pulling the CSX signal high during a command or data byte. The display module shall reset its interface so it will be ready to receive the same byte when CSX is again driven low.

The host processor can pause a read or write sequence by pulling the CSX signal high between command or data bytes. The display module shall wait for the host processor to drive CSX low before continuing the read or write sequence at the point where the sequence was paused.

1. Middle of frame
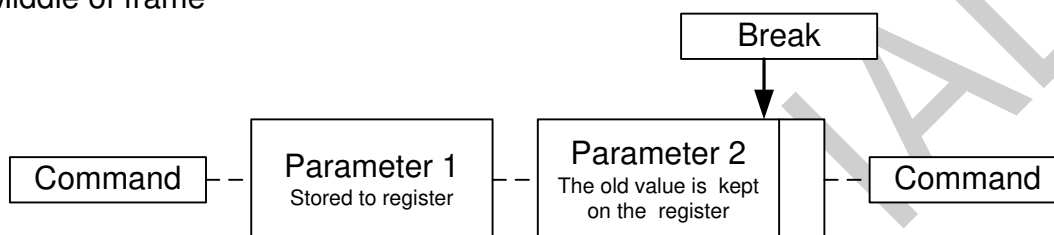
2. Between frames

Without break

With break
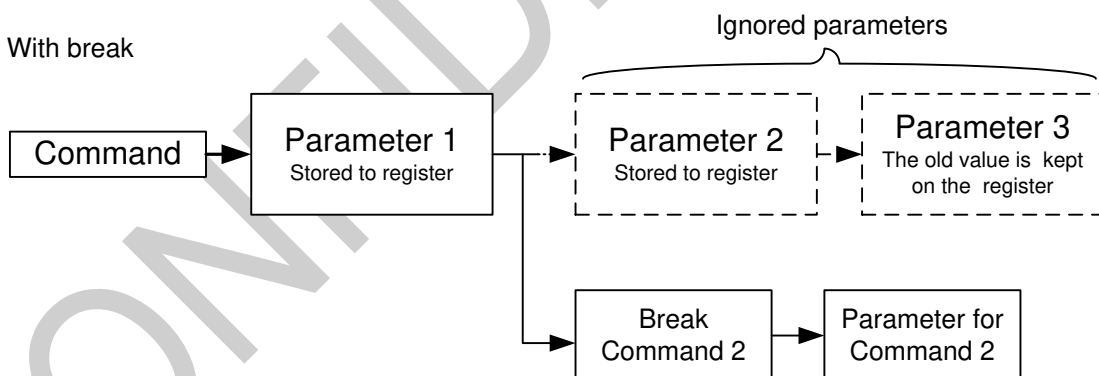
Break can be e.g. another command or noise pulse.

5.3 Display Serial Interface (DSI)

DSI-compliant peripherals support either of two basic modes of operation: Command Mode and Video Mode. The mode definitions reflect the primary intended use of DSI for display interconnect, but are not intended to restrict DSI from operating in other applications.

RM69090 is capable of both Command Mode operation and Video Mode operation. Command Mode refers to operation in which transactions primarily take the form of sending commands and data to a display module that incorporates a display controller. The display controller may include local registers and a frame buffer. Systems using Command Mode write to, and read from, the registers and frame buffer memory. The host processor indirectly controls activity at the peripheral by sending commands, parameters and data to the display controller.

The host processor can also read display module status information or the contents of the frame memory. Command Mode operation requires a bidirectional interface. Video Mode refers to operation in which transfers from the host processor to the peripheral take the form of a real-time pixel stream. In normal operation, the display module relies on the host processor to provide image data at sufficient bandwidth to avoid flicker or other visible artifacts in the displayed image. Video information should only be transmitted using High Speed Mode.

RM69090 Video Mode architectures also include a simple timing controller and partial frame buffer, used to maintain a partial-screen or lower-resolution image in standby or Low Power Mode. This permits the interface to reduce power consumption.

RM69090 Configuration:

Lane Pair	MCU(Master) RM69090(Slave)
Clock Lane	Unidirectional Lane Clock only
Data Lane 0	Bi-directional Lane Forward High-speed Bi-directional Escape Mode Bi-directional LPDT
Data Lane 1	Unidirectional Lane Forward High-Speed Escape Mode No LPDT

5.3.1 DSI Protocol

On the transmitter side of a DSI Link, parallel data, signal events, and commands are converted to packets. These packets are sent across the serial Link. The receiver side of a DSI Link performs the converse of the transmitter side, decomposing the packet into parallel data, signal events and commands.
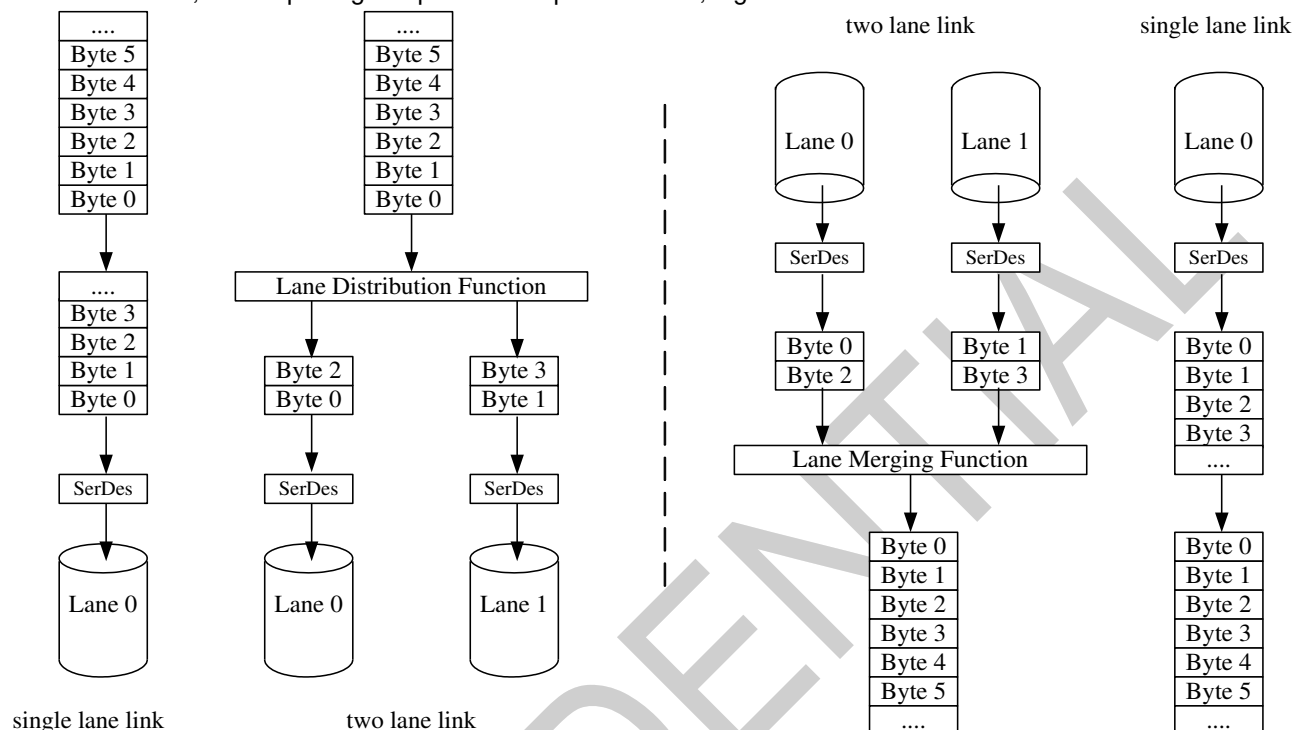
There are two kinds of packets, **short packet and long packet**.

Short packet structure:
LP-11: low power mode
SoT: start of transmission
DI: data identification
Data 0, Data1: packet data
ECC: error correction code
EoT: End of Transmission
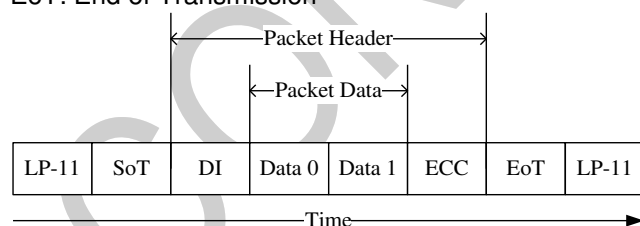
DI structure:
Virtual Channel: these two bits identify the data as directed to one of four virtual channels
Data Type: It specifies the packet structure and packet format

Virtual Channel (VC)		Data Type (DT)					
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0

Long packet structure:
LP-11: low power mode
SoT: start of transmission
DI: data identification
Word Count: the number of data bytes of packet data
ECC: error correction code
Checksum: The 16-bit CRC generator to check packet data. If the calculated checksum of receiver are equal to the packet data, the packet data is correct. If the calculated checksum of receiver are not equal, the packet data are not correct.

EoT: end of transmission

		←——Packet Header——→									
LP-11	SoT	DI	Word Count	ECC	Data 0	Data 1	...	Data WC-2	Data WC-1	checksum	EoT	LP-11

—————————————————————————Time—————————————————————————→
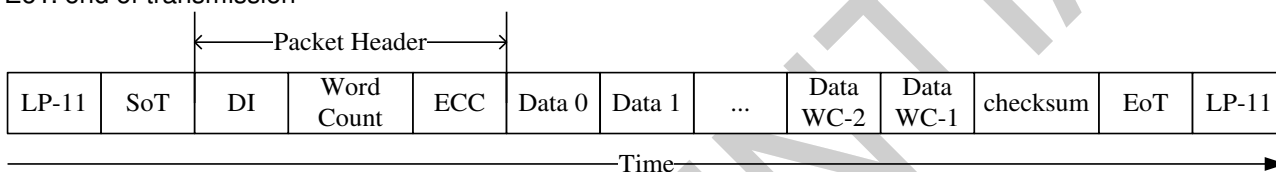
5.3.2 Processor to Peripheral Transactions

Processor to Peripheral Direction Packet Data Types

Data Type	Data Type binary	Description	Packet Size
01h	00 0001	Sync Event, V Sync Start	Short
11h	01 0001	Sync Event, V Sync End	Short
21h	10 0001	Sync Event, H Sync Start	Short
31h	11 0001	Sync Event, H Sync End	Short
08h	00 1000	End of Transmission packet (EoTp)	Short
02h	00 0010	Color Mode (CM) Off Command	Short
12h	01 0010	Color Mode (CM) On Command	Short
22h	10 0010	reserved	Short
32h	11 0010	reserved	Short
03h	00 0011	reserved	Short
13h	01 0011	Generic Short WRITE, 1 parameter	Short
23h	10 0011	Generic Short WRITE, 2 parameters	Short
04h	00 0100	reserved	Short
14h	01 0100	Generic READ, 1 parameter	Short
24h	10 0100	Generic READ, 2 parameters	Short
05h	00 0101	DCS Short WRITE, no parameters	Short
15h	01 0101	DCS Short WRITE, 1 parameter	Short
06h	00 0110	DCS READ, no parameters	Short
37h	11 0111	Set Maximum Return Packet Size	Short
09h	00 1001	Null Packet, no data	Long
19h	01 1001	Blanking Packet, no data	Long
29h	10 1001	Generic Long Write	Long
39h	11 1001	DCS Long Write/write_LUT Command Packet	Long
0Eh	00 1110	Packed Pixel Stream, 16-bit RGB, 5-6-5 Format	Long
1Eh	01 1110	Packed Pixel Stream, 18-bit RGB, 6-6-6 Format	Long
2Eh	10 1110	Loosely Packed Pixel Stream, 18-bit RGB, 6-6-6 Format	Long
3Eh	11 1110	Packed Pixel Stream, 24-bit RGB, 8-8-8 Format	Long

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Sync Event, Data Type = xx 0001
Sync Events are all short packets and time-accurately. They can perform like the start and end of sync pulses. To represent timing information as accurately as possible, a V Sync Start event represents the start of the VSA and also implies an H Sync Start event for the first line of the VSA. Hence, a V Sync End event implies an H Sync Start event for the last line of the VSA. Sync events may be concatenated with blanking packets to convey inter-line timing accurately and avoid the overhead of switching between LPS and HS for every event. Note there is a power penalty for keeping the data line in HS mode.

EoT packet
This short packet is used to indicate the end of a high speed (HS) transmission. This packet will enhance overall syntem reliability. Although the main objective of the EoTp is to enhance robustness during HS transmission mode, RM69090 can detect and interpret arriving EoTps regardless of transmission mode (HS or LP modes)

Color Mode Off / On Command
They are short packet commands to switch video display module between normal display mode and low-color mode for power saving.

Generic short write / read packet
Generic Short WRITE command is a Short packet type for sending generic data to the peripheral. Generic READ request is a Short packet requesting data from the peripheral.

DCS commands
DCS short write command
DCS short write command is used to write a single data byte command to display module. If there is a valid parameter byte, data type bit 4 shall be set to 1. If there is no valid parameter byte, data type bit 4 shall be set to 0 and the parameter byte shall be 00h.

DCS read commands
The commands are used to request data from s display module.

DCS Long Write / write_LUT command
The commands are used to send larger blocks of data to a display module.

Maximum return packet size
This command specifies the maximum size of the payload in a long packet transmission from a display module to host processor.

Null Packet
This is a mechanism for keeping the data lane(s) in high speed mode while sending dummy data.

Blanking Packet
A Blanking packet is used to convey blanking timing information in a Long packet. The packet represents a period between active scan lines of a Video Mode display, where traditional display timing is provided from the host processor to the display module. The blanking period may have Sync Event packets interspersed between blanking segments. Blanking packets may contain arbitrary data as payload.

Generic Long Write
This is used to transmit arbitrary blocks of data from a host processor to a peripheral.

Packed Pixel Stream, 16-bit Format, Data Type: 00 1110
The pixel format is five bits red, six bits green and five bits blue. The green component is split across two bytes. Within a color component, the LSB is sent first, the MSB last.

B: byte, b: bit
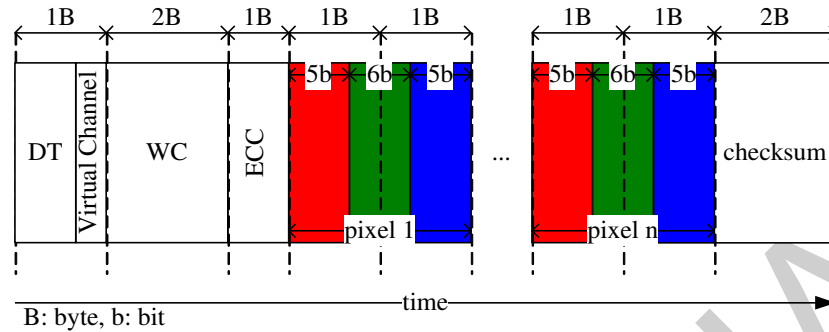
Packet pixel stream, 18-bit format, Data Type: 01 1110
The pixel format is six bits red, six bits green and six bits blue. Within a color component, the LSB is sent first, the MSB last.
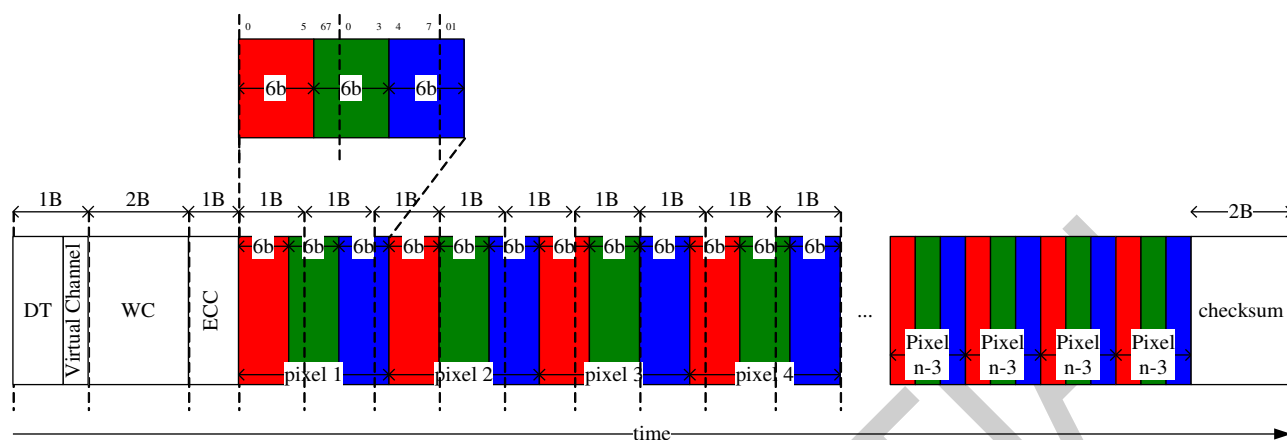
Packet pixel stream, 18-bit format in three bytes, Data Type: 10 1110
This is 18-bit pixel lossely packed format, each R, G or B color component is six bits but shifted to the upper bits of byte.
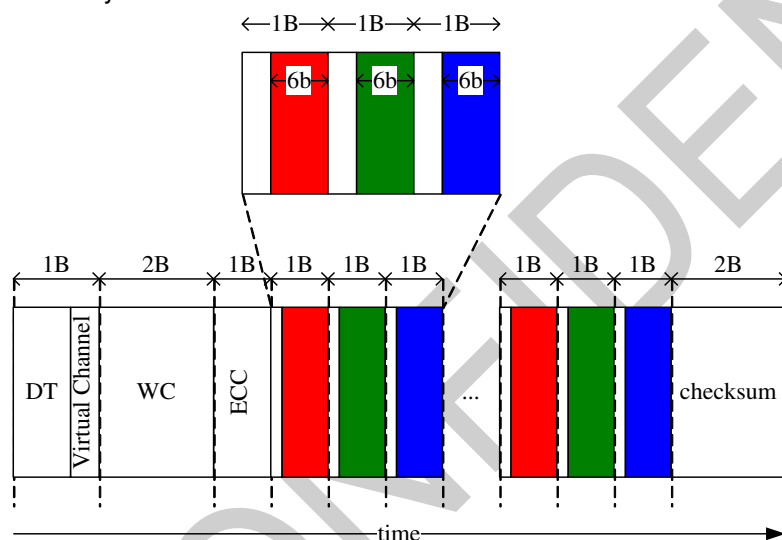
Packet pixel stream, 24-bit format, Data Type: 11 1110
The pixel format is eight bits red, eight bits green and eight bits blue.
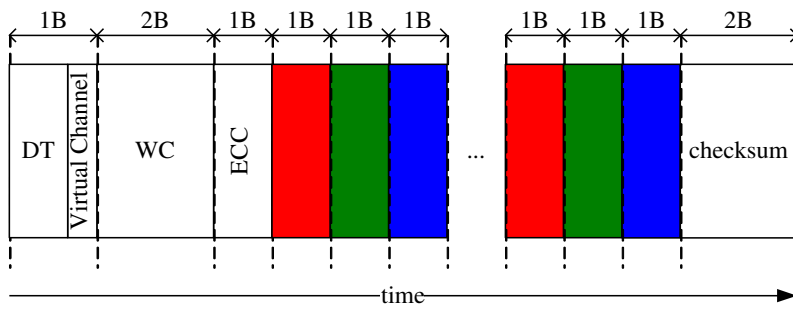
5.3.3 Peripheral-to-Processor LP Transmission

All Command Mode systems require bidirectional capability for returning READ data, acknowledge, or error information to the host processor. Multi-Lane systems shall use Lane 0 for all peripheral-to-processor transmissions. Reverse-direction signaling shall only use low power mode transmission.

Packet structure for peripheral-to-processor transaction is the same as for the processor-to-peripheral direction. For the processor-to-peripheral direction, two basic packet formats are the same as the peripheral-to-processor direction: Short and Long packet structure. BTA shall take place after every peripheral-to-processor transaction. This returns bus control to the host processor following the completion of the LP transmission from the peripheral.

There are four basic types of peripheral-to-processor transactions.

Tearing Effect: It is a Trigger message sent to convey display timing information to the host processor. Acknowledge: It is a Trigger Message sent when the current transmission, as well as all preceding transmissions since the last peripheral to host communication.

Acknowledge and Error Report: It is a Short packet sent if any errors were detected in preceding transmissions from the host processor.
Response to Read Request: It may be a Short or Long packet that returns data requested by the preceding READ command from the processor.

Interpretation of processor-to-peripheral transactions with BTA asserted, and the expected responses, are as follows:
Following a non-Read command: If no errors were detected, the peripheral shall respond with Acknowledge.

Following a Read request: The peripheral shall send the requested READ data if no errors were detected and stored since the last peripheral to host communication.

Following a Read request: If only a single-bit ECC error was detected and corrected, the peripheral shall send the requested READ data in a Long or Short packet and a 4-byte Acknowledge and Error Report packet in the same LP transmission.

Following a non-Read command: If only a single-bit ECC error was detected and corrected, the peripheral shall respond to BTA by sending a 4-byte Acknowledge and Error Report packet.

Following a Read request: If multi-bit ECC errors were detected and not corrected, the peripheral shall send a 4-byte Acknowledge and Error Report packet without sending Read data.

Following a non-Read command: If multi-bit ECC errors were detected and not corrected, the peripheral shall not execute the command, and shall send a 4-byte Acknowledge and Error Report packet.

Following any command: If SoT Error, SoT Sync Error, the VC of DSI or the ID of DSI Invalid or DSI protocol violation was detected, or the DSI command was not recognized, the peripheral shall send a 4-byte Acknowledge and Error Report response.

Following any command: If EoT Sync Error or LP Transmit Sync Error is detected, or a checksum error is detected in the payload, the peripheral shall send a 4-byte Acknowledge and Error Report packet.

5.3.4 Error Report Format

The following table shows the bit assignment for all error report.

Bit	Description
0	SoT Error
1	SoT Sync Error
2	EoT Sync Error
3	Escape Mode Entry Command Error
4	Low-Power Transmit Sync Error
5	HS Receive Timeout Error
6	False Control Error
7	Reserved
8	ECC Error, single-bit (detected and corrected)
9	ECC Error, multi-bit (detected, not corrected)
10	Checksum Error (Long packet only)
11	DSI Data Type Not Recognized
12	DSI VC ID Invalid
13	reserved
14	reserved
15	reserved

5.3.5 Peripheral-to-Processor Transaction – Detail Format Description
The following list is the complete set of peripheral-to-processor data types.

Data type, hex	Data type binary	Description	Packet size
02h	00 0010	Acknowledge and error report	short
08h	00 1000	reserved	short
11h	01 0001	GEN short read reponse, 1byte returned	short
12h	01 0010	GEN short read reponse, 2bytes returned	short
1Ah	01 1010	Generic long read reponse	long
1Ch	01 1100	DCS long read reponse	long
21h	10 0001	DCS short read reponse, 1byte returned	short
22h	10 0010	DCS short read reponse, 2bytes returned	short

Acknowledge and error report: It is sent with BTA asserted when a reportable error is detected in the preceding, or earlier, transmission from the host processor.

Generic Short Read Response: This is the short-packet response to Generic READ Request. Packet composition is the Data Identifier (DI) byte, two bytes of payload data and an ECC byte. If the command itself is possibly corrupt, due to an uncorrectable ECC error, SoT or SoT Sync error, the requested READ data packet shall not be sent and only the Acknowledge and Error Report packet shall be sent.

Generic long read reponse: This is the long-packet response to Generic READ Request. Packet composition is DI followed by a two-byte Word Count, an ECC byte, N bytes of payload, and a two-byte Checksum. If the command itself is possibly corrupt, due to an uncorrectable ECC error, SoT or SoT Sync error, the requested READ data packet shall not be sent and only the Acknowledge and Error Report packet shall be sent.

DCS long read reponse: This is a Long packet response to DCS Read Request. Packet composition is DI followed by a two-byte Word Count, an ECC byte, N bytes of payload, and a two-byte Checksum. If the DCS command itself is possibly corrupt, due to uncorrectable ECC error, SoT or SoT Sync error, the requested READ data packet shall not be sent and only the Acknowledge and Error Report packet shall be sent.

DCS short read reponse: This is the short-packet response to DCS Read Request. Packet composition is DI, two bytes of payload data and an ECC byte. If the command itself is possibly corrupt, due to an uncorrectable ECC error, SoT or SoT Sync error, the requested READ data packet shall not be sent and only the Acknowledge and Error Report packet shall be sent.

5.3.6 DSI Video Mode Interface Timing

t_L * (VSA + VBP + VACT + VFP)

Active Video Area

VSA Lines | VBP Lines | VFP Lines

VACT Lines

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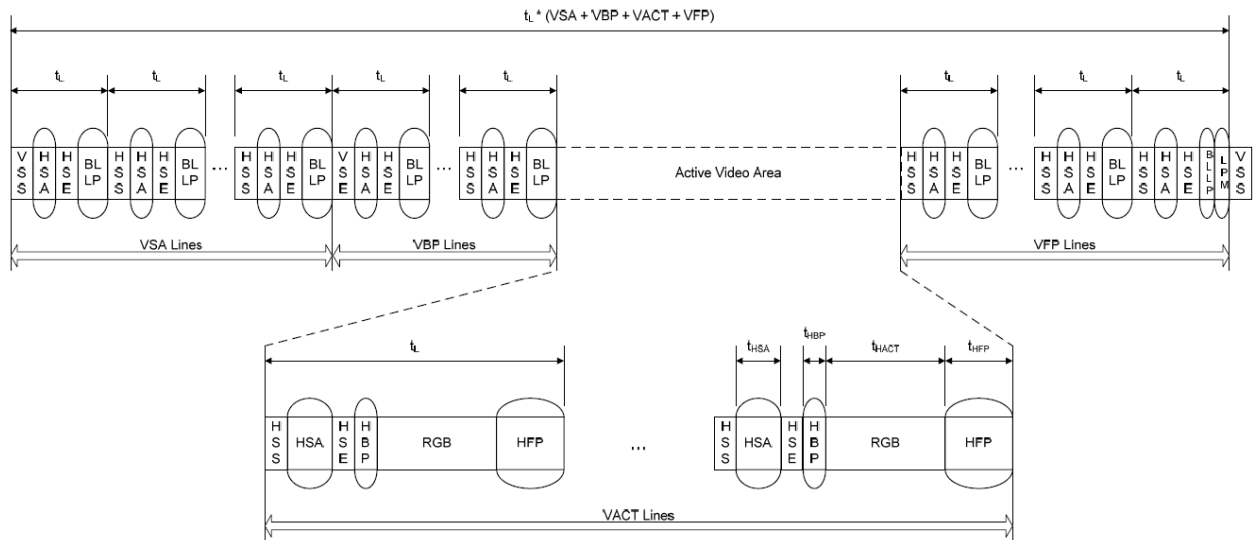
5.3.7 Error Correction Code (ECC)

ECC shall always be generated and appended in the Packet Header from the host processor. Peripherals with Bidirectional Links shall also generate and send ECC.

The number of parity or error check bits required is given by the Hamming rule, which uses parity to correct a single-bit error or detect a two-bit error, but are not capable of doing both simultaneously. DSI uses Hamming-modified codes where an extra parity bit is used to support both single error correction as well as two-bit error detection.

Since Packet Headers are fixed at four bytes (twenty-four data bits and eight ECC bits), P6 and P7 of the ECC byte are unused and shall be set to zero by the transmitter. The receiver shall ignore P6 and P7 and set both bits to zero before processing ECC.

The parity bits of ECC are defined as below:
P7 = 0
P6 = 0
P5 = D10^D11^D12^D13^D14^D15^D16^D17^D18^D19^D21^D22^D23
P4 = D4^D5^D6^D7^D8^D9^D16^D17^D18^D19^D20^D22^D23
P3 = D1^D2^D3^D7^D8^D9^D13^D14^D15^D19^D20^D21^D23
P2 = D0^D2^D3^D5^D6^D9^D11^D12^D15^D18^D20^D21^D22
P1 = D0^D1^D3^D4^D6^D8^D10^D12^D14^D17^D20^D21^D22^D23
P0 = D0^D1^D2^D4^D5^D7^D10^D11^D13^D16^D20^D21^D22^D23

The table below shows a compact way to specify the encoding of parity and decoding of syndromes.

ECC Parity Generation Rules:

Data Bit	P7	P6	P5	P4	P3	P2	P1	P0	Hex
0	0	0	0	0	0	1	1	1	0x07
1	0	0	0	0	1	0	1	1	0x0B
2	0	0	0	0	1	1	0	1	0x0D
3	0	0	0	0	1	1	1	0	0x0E
4	0	0	0	1	0	0	1	1	0x13
5	0	0	0	1	0	1	0	1	0x15
6	0	0	0	1	0	1	1	0	0x16
7	0	0	0	1	1	0	0	1	0x19
8	0	0	0	1	1	0	1	0	0x1A
9	0	0	0	1	1	1	0	0	0x1C
10	0	0	1	0	0	0	1	1	0x23
11	0	0	1	0	0	1	0	1	0x25
12	0	0	1	0	0	1	1	0	0x26
13	0	0	1	0	1	0	0	1	0x29
14	0	0	1	0	1	0	1	0	0x2A
15	0	0	1	0	1	1	0	0	0x2C
16	0	0	1	1	0	0	0	1	0x31
17	0	0	1	1	0	0	1	0	0x32
18	0	0	1	1	0	1	0	0	0x34
19	0	0	1	1	1	0	0	0	0x38
20	0	0	0	1	1	1	1	1	0x1F
21	0	0	1	0	1	1	1	1	0x2F
22	0	0	1	1	0	1	1	1	0x37
23	0	0	1	1	1	0	1	1	0x3B

5.3.8 Notice
1. We recommend users to stay in STOP state for 500ns when switching from LPDT to HSDT.
2. We recommend users to adopt EoTp to enhance overall robustness of the system during HSDT.

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5.4 Tearing Effect Output

The tearing effect output line supplies to the HOST a panel synchronization signal. This signal can be enabled or disabled by the set_tear_off (34h) and set_tear_on (35h) commands. The mode of the tearing effect signal is defined by the parameter of the set_tear_on (35h) and set_tear_scanline(44h) commands. The signal can be used by the HOST to synchronize internal VSYNC when displaying video images.

5.4.1 Tearing Effect Line Mode

Mode 1, the tearing effect output signal consist of V-sync information only:
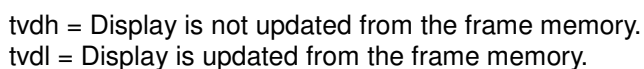
tvdh = Display is not updated from the frame memory.
tvdl = Display is updated from the frame memory.

Mode 2, the tearing effect output signal consist of V-sync and H-sync information:

thdh = Display is not updated from the frame memory.
thdl = Display is updated from the frame memory.

Mode 3, this mode turn on the tearing effect output signal when vertical scanning reachs line N.

N = The N-th scanning line which set by register N[15:0] of command STESL(44h).
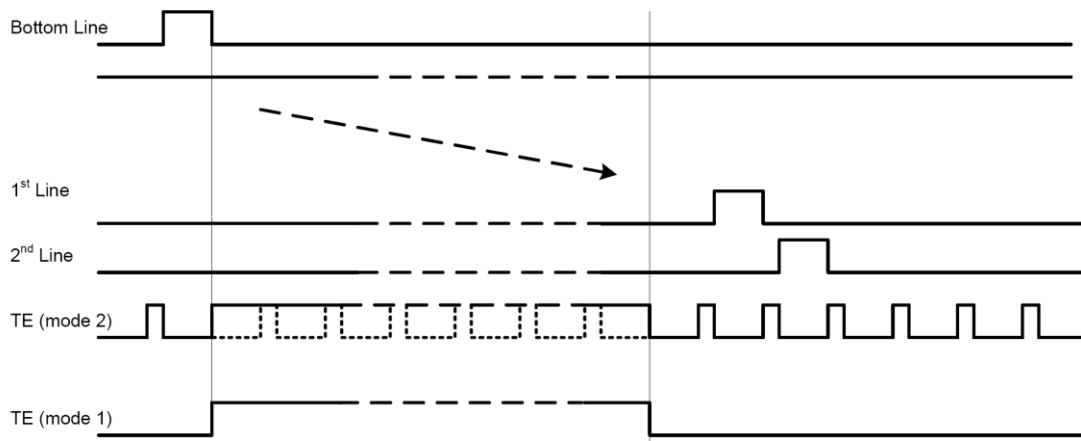
Note. During Sleep In mode, the tearing effect output signal is active low.

5.4.2 Tearing Effect Line Timing

The tearing effect signal is described as below:
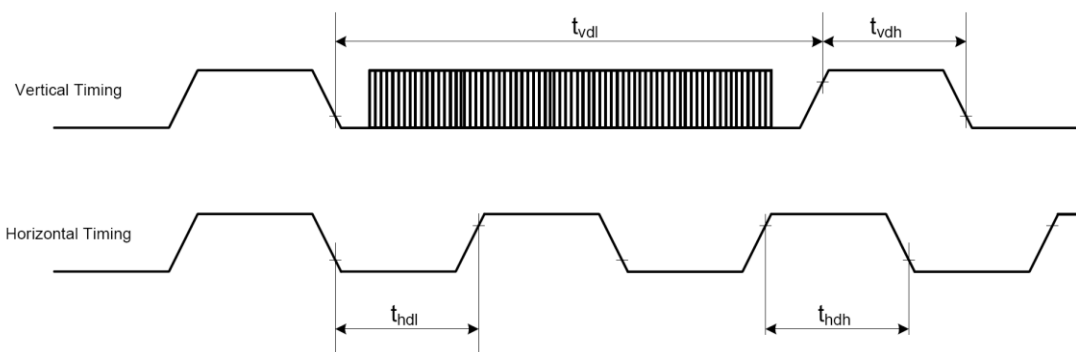
AC characteristics of Tearing Effect Signal (Frame Rate = 60.5Hz)

Symbol	Parameter	Typ.	Unit	Description
tvdl	Vertical timing low duration			1*frame time- tvdh
tvdh	Vertical timing high duration			tvdh =V Porch time if STS[15:0]=0. tvdh =31* line time if STS[15:0] not equal to 0.
thdl	Horizontal timing low duration			1* line time- 32*PCLK
thdh	Horizontal timing high duration	1.45	us	32*PCLK

Notes:

1. The signal's rise and fall times (tf, tr) are stipulated to be equal to or less than 15ns.
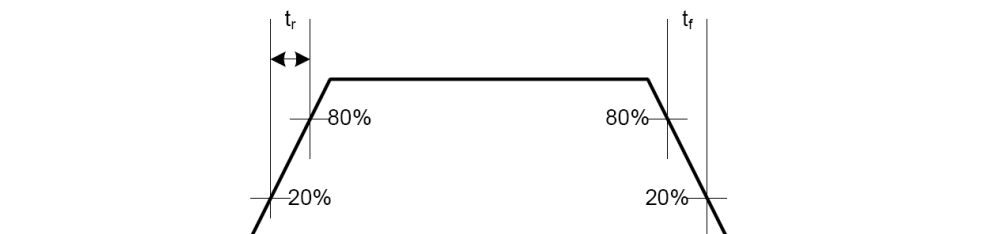
The Tearing Effect Output Line is fed back to the HOST and should be used as shown below to avoid tearing effect:

The Tearing Effect output line supplies to the HOST a panel synchronization signal. This signal can be enabled or disabled by the set_tear_off(34h), set_tear_on(35h) commands. The mode of the Tearing Effect Signal is defined by the Parameter of the Tearing Effect Line On command. The signal can be used by the HOST to synchronize internal VSYNC when displaying video images.

TEON (35h)	TELOM (35h, 1st bit)	TE signal Output
0	*	GND
1	0	TE (Mode 1)
1	1	TE (Mode 2)

6. Command

6.1 Command List

Page	Add.	Para.	W/R	Function	D7	D6	D5	D4	D3	D2	D1	D0	Default (hex)	MTP
CMD1	00h	-	W	NOP	No Argument								-	-
CMD1	01h	-	W	Software reset	No Argument								-	-
CMD1	04h	1st	R	Read display identification information	ID1[7:0]								00h	-
CMD1	04h	2nd			ID2[7:0]								80h	-
CMD1	04h	3rd			ID3[7:0]								00h	-
CMD1	05h	-	R	Read number of the errors on DSI	P[7:0]								00h	-
CMD1	0Ah	1st	R	Read display power mode	BSTON	IDMON	PTLON	SLPOUT	NORON	DISPON	-	-	08h	-
CMD1	0Bh	1st	R	Read display MADCTR	-	MX	-	-	RGB	-	-	-	00h	-
CMD1	0Ch	1st	R	Read display pixel format	SPI_IFPF_SEL	VIPF2	VIPF1	VIPF0	-	IFPF2	IFPF1	IFPF0	77h	-
CMD1	0Dh	1st	R	Read display image mode	0	0	INVON	ALLPON	ALLPOFF	0	0	0	00h	-
CMD1	0Eh	1st	R	Read display signal mode	TEON	M	0	0	0	0	0	ERR	00h	-
CMD1	0Fh	1st	R	Read display self-diagnostic result	0	0	0	0	0	0	0	checksum_comp	00h	-
CMD1	10h	-	W	Sleep-in	No Argument								-	-
CMD1	11h	-	W	Sleep-out	No Argument								-	-
CMD1	12h	-	W	Partial display mode on	No Argument								-	-
CMD1	13h	-	W	Normal display mode on	No Argument								-	-
CMD1	20h	-	W	Display inversion off	No Argument								-	-
CMD1	21h	-	W	Display inversion on	No Argument								-	-
CMD1	22h	-	W	All pixel off	No Argument								-	-
CMD1	23h	-	W	All pixel on	No Argument								-	-
CMD1	28h	-	W	Display off	No Argument								-	-
CMD1	29h	-	W	Display on	No Argument								-	-
CMD1	2Ah	1st	W	Set column start address	SC[9:8]								00h	-
CMD1		2nd	W		SC[7:0]								00h	-
CMD1		3rd	W		EC[9:8]								01h	-
CMD1		4th	W		EC[7:0]								8Fh	-
CMD1	2Bh	1st	W	Set row start address	SP[9:8]								00h	-
CMD1		2nd	W		SP[7:0]								00h	-
CMD1		3rd	W		EP[9:8]								01h	-
CMD1		4th	W		EP[7:0]								8Fh	-
CMD1	2Ch	-	W	Memory write	No Argument								-	-
CMD1	30h	1st	W	Partial area	SR[9:8]								00h	-
CMD1		2nd	W		SR[7:0]								00h	-
CMD1		3rd	W		ER[9:8]								01h	-
CMD1		4th	W		ER[7:0]								8Fh	-
CMD1	31h	1st	W	Vertical partial area	PSC[9:8]								00h	-
CMD1		2nd	W		PSC[7:0]								00h	-
CMD1		3rd	W		PEC[9:8]								01h	-
CMD1		4th	W		PEC[7:0]								8Fh	-
CMD1	34h	-	W	Tearing effect line off	No Argument								-	-
CMD1	35h	-	W	Tearing effect line on	0	0	0	0	0	0	TE_M	TELOM	00h	-
CMD1	36h	-	W	Scan direction control	MADCTR[7:0]								00h	-
CMD1	38h	-	W	Idle mode off	No Argument								-	-
CMD1	39h	-	W	Enter idle mode	No Argument								-	-
CMD1	3Ah	-	W	Interface Pixel Format	SPI_IFPF_SEL	VIPF2	VIPF1	VIPF0	0	IFPF[2]	IFPF[1]	IFPF[0]	77h	-
CMD1	3Ch	-	W	Memory Continuous Write	No Argument								-	-
CMD1	44h	1st	W	Set tear scan-line	STS[15:8]								00h	-
CMD1		2nd	W		STS[7:0]								00h	-
CMD1	45h	1st	R	Get scan line	GTS[15:8]								00h	-

CMD1		2nd	R		GTS[7:0]								00h	-
CMD1	4Fh	-	W	Deep standby	0	0	0	0	0	0	0	DSTB	00h	-
CMD1	51h	-	W	Write display brightness	DBV[7:0]								00h	-
CMD1	52h	-	R	Read display brightness	DBV[7:0]								00h	-
CMD1	53h	-	W	Write CTRL display	0	0	BCTRL	0	DD	0	0	0	28h	-
CMD1	54h	-	R	Read CTRL display	0	0	BCTRL	0	DD	0	0	0	28h	-
CMD1	55h	-	W	Write RAD_ACL function	0	0	0	0	0	0	RAD_ACL[1:0]		00h	-
CMD1	56h	-	R	Read RAD_ACL function	0	0	0	0	0	0	RAD_ACL[1:0]		00h	-
CMD1	58h	-	W	Set color enhancement	0	0	0	0	0	SLR_EN	SLR_LEVE L1	SLR_LEVE L0	00h	-
CMD1	59h	-	R	Read color enhancement	0	0	0	0	0	SLR_EN	SLR_LEVE L1	SLR_LEVE L0	00h	-
CMD1	63h	-	W	Write HBM display brightness	DBV_HBM[7:0]								00h	
CMD1	64h	-	R	Read HBM display brightness	DBV_HBM[7:0]								00h	
CMD1	66h		W	HBM enable	-	-	-	-	-	-	HBM_en	-	00h	
CMD1	67h		W	Deep idle enable	-	-	-	-	-	-	-	DEEP_IDL E_EN	00h	
CMD1		1st	W	COLSET	R_0000[7:0]								00h	
CMD1	70h	2nd	W	COLSET	G_0000[7:0]								00h	
CMD1		3rd	W	COLSET	B_0000[7:0]								00h	
CMD1		1st	W	COLSET	R_0001[7:0]								00h	
CMD1	71h	2nd	W	COLSET	G_0001[7:0]								00h	
CMD1		3rd	W	COLSET	B_0001[7:0]								FFh	
CMD1		1st	W	COLSET	R_0010[7:0]								00h	
CMD1	72h	2nd	W	COLSET	G_0010[7:0]								FFh	
CMD1		3rd	W	COLSET	B_0010[7:0]								00h	
CMD1		1st	W	COLSET	R_0011[7:0]								00h	
CMD1	73h	2nd	W	COLSET	G_0011[7:0]								FFh	
CMD1		3rd	W	COLSET	B_0011[7:0]								FFh	
CMD1		1st	W	COLSET	R_0100[7:0]								FFh	
CMD1	74h	2nd	W	COLSET	G_0100[7:0]								00h	
CMD1		3rd	W	COLSET	B_0100[7:0]								00h	
CMD1		1st	W	COLSET	R_0101[7:0]								FFh	
CMD1	75h	2nd	W	COLSET	G_0101[7:0]								00h	
CMD1		3rd	W	COLSET	B_0101[7:0]								FFh	
CMD1		1st	W	COLSET	R_0110[7:0]								FFh	
CMD1	76h	2nd	W	COLSET	G_0110[7:0]								FFh	
CMD1		3rd	W	COLSET	B_0110[7:0]								00h	
CMD1		1st	W	COLSET	R_0111[7:0]								FFh	
CMD1	77h	2nd	W	COLSET	G_0111[7:0]								FFh	
CMD1		3rd	W	COLSET	B_0111[7:0]								FFh	
CMD1		1st	W	COLSET	R_1000[7:0]								00h	
CMD1	78h	2nd	W	COLSET	G_1000[7:0]								00h	
CMD1		3rd	W	COLSET	B_1000[7:0]								00h	
CMD1		1st	W	COLSET	R_1001[7:0]								00h	
CMD1	79h	2nd	W	COLSET	G_1001[7:0]								00h	
CMD1		3rd	W	COLSET	B_1001[7:0]								FFh	
CMD1		1st	W	COLSET	R_1010[7:0]								00h	
CMD1	7Ah	2nd	W	COLSET	G_1010[7:0]								FFh	
CMD1		3rd	W	COLSET	B_1010[7:0]								00h	
CMD1		1st	W	COLSET	R_1011[7:0]								00h	
CMD1	7Bh	2nd	W	COLSET	G_1011[7:0]								FFh	
CMD1		3rd	W	COLSET	B_1011[7:0]								FFh	
CMD1		1st	W	COLSET	R_1100[7:0]								FFh	
CMD1	7Ch	2nd	W	COLSET	G_1100[7:0]								00h	
CMD1		3rd	W	COLSET	B_1100[7:0]								00h	
CMD1		1st	W	COLSET	R_1101[7:0]								FFh	
CMD1	7Dh	2nd	W	COLSET	G_1101[7:0]								00h	
CMD1		3rd	W	COLSET	B_1101[7:0]								FFh	

CMD1		1st	W	COLSET	R_1110[7:0]									FFh	
CMD1	7Eh	2nd	W	COLSET	G_1110[7:0]									FFh	
CMD1		3rd	W	COLSET	B_1110[7:0]									00h	
CMD1		1st	W	COLSET	R_1111[7:0]									FFh	
CMD1	7Fh	2nd	W	COLSET	G_1111[7:0]									FFh	
CMD1		3rd	W	COLSET	B_1111[7:0]									FFh	
CMD1	80h	1st	W	COLOPT	-	RGB111_opt	-	-	RGB4bit_en	gray256_color[2]	gray256_color[1]	gray256_color[0]		07h	
CMD1		1st	R		SID[7:0]									D0h	-
CMD1		2nd	R		SID[15:8]									01h	-
CMD1	A1h	3rd	R	Read DDB	MID[7:0]									80h	-
CMD1		4th	R		MID[15:8]									90h	-
CMD1		5th	R		1	1	1	1	1	1	1	1		FFh	-
CMD1		1st	R		SID[7:0]									D0h	-
CMD1		2nd	R		SID[15:8]									01h	-
CMD1	A8h	3rd	R	Read DDB Continuous	MID[7:0]									80h	-
CMD1		4th	R		MID[15:8]									90h	-
CMD1		5th	R		1	1	1	1	1	1	1	1		FFh	-
CMD1	AAh	-	R	Read first checksum	FCS[7:0]									00h	-
CMD1	AFh	-	R	Read continuous checksum	CCS[7:0]									00h	-
CMD1	C2h			Set_DSIP Mode	0	0	0	0	0	0	DM1	DM0		00h	-
CMD1	C4h			Set_DSPI Mode	SPI_WRAM	0	DSPI_CFG1	DSPI_CFG0	0	0	0	DSPI_EN		00h	-
CMD1	DAh	-	R	Read display identification information (the same as 04h)	ID1[7:0]									00h	-
CMD1	DBh	-	R		ID2[7:0]									80h	-
CMD1	DCh	-	R		ID3[7:0]									00h	-
CMD1	FEh	-	W	Write CMD mode page	0	0	0	0	CMD_Page[3:0]					00h	-
CMD1	FFh	-	R	Read CMD page Status	0	0	0	0	CMD_Status[3:0]					00h	-

6.2 Command Description

NOP (0000h)

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	0000h				No Argument					

Description	This command is an empty command; it does not have any effect on the display module. X = Don't care.
Restriction	None

SWRESET(0100h) : Software Reset

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	0100h				No Argument					

Description	When the Software Reset command is written, it causes software reset. It resets the commands and parameters to their S/W Reset default values. (See default tables in each command description.)
Restriction	Software Reset Command cannot be sent during Sleep Out sequence. Any new command cannot be sent for 10-frame period until the RM69090 enters Sleep-In mode. Do not send any command.

RDDID(0400h~0402h) : Read Display ID

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	0400h	ID17	ID16	ID15	ID14	ID13	ID12	ID11	ID10	00
	0401h	ID27	ID26	ID25	ID24	ID23	ID22	ID21	ID20	80
	0402h	ID37	ID36	ID35	ID34	ID33	ID32	ID31	ID30	00

Description	The 1st parameter (ID1): the Module's manufacture ID The 2nd parameter (ID2): the Module/driver version ID The 3rd parameter (ID3): the Module/driver ID Note: Commands RDID1/2/3 (DAh/DBh/DCh) read data correspond to the parameter 1, 2, 3 of command 04h, respectively.
Restriction	-

RDNUMED(0500h) : Read Number of Errors on DSI

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	0500h	D7	D6	D5	D4	D3	D2	D1	D0	00

Description	The first parameter is telling a number of the parity errors on DSI. The more detailed description of the bits is below. D[6..0] bits are telling a number of the parity errors. D[7] is set to "1" if there is overflow with D[6..0] bits. D[7..0] bits are set to "0"s (as well as RDDSM(0Eh)'s D0 are set "0" at the same time) after there is sent the first parameter information (= The read function is completed). This command is used for MIPI DSI only. It is no function for others interface operation.
Restriction	-

RDDPM (0A00h) : Read Display Power Mode

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	0A00h	D7	D6	D5	D4	D3	D2	D1	D0	08

Description	This command indicates the current status of the display as described in the table below:

Bit	Symbol	Description	Comment
D7	BSTON	Booster Voltage Status	'1'=Booster on, '0'=Booster off
D6	IDMON	Idle Mode On/Off	'1' = Idle Mode On, '0' = Idle Mode Off
D5	PTLON	Partial Mode On/Off	'1' = Partial Mode On, '0' = Partial Mode Off
D4	SLPON	Sleep In/Out	'1' = Sleep Out, '0' = Sleep In
D3	NORON	Display Normal Mode On/Off	'1' = Normal Display, '0' = Partial Display
D2	DISON	Display On/Off	'1' = Display On, '0' = Display Off
D1	Reserved		0
D0	Reserved		0

RDDMADCTR (0B00h): Read Display MADCTR

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	0B00h	D7	D6	D5	D4	D3	D2	D1	D0	00

Description	This command indicates the current status of the display as described in the table below: | Bit	Symbol	Description	Comment
---	---	---	---
D6	MX	Column Address Increment	0: Increasing in horizontal 1: Decreasing in horizontal
D3	RGB	RGB/BGR Order	'1' =BGR, "0"=RGB
others	Reserved	-	-	

RDDCOLMOD (0C00h): Read Display Pixel Format

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	0C00h	SPI_IFPF_SE	VIPF[0]	VIPF[0]	VIPF[0]	0	IFPF[2]	IFPF[1]	IFPF[0]	77

Description	To return the status of 0x3A00. This command sets the pixel format for the RGB image data used by the interface. If SPI_IFPF_SEL(3Ah-B7) = 1: The VIPF[2:0] pixel format used by the SPI interface If SPI_IFPF_SEL(3Ah-B7) = 0: The IFPF[2:0] pixel format used by the SPI / MCU interface

Control Interface Color Format	IFPF[2]	IFPF[1]	IFPF[0]
SPI 8 bit/pixel (256 colors); SPI 256 Gray (Support IF: SPI3/SPI4)	0	0	1
SPI 8 bit/pixel (256 colors); SPI 3-3-2 (Support IF: SPI3/SPI4)	0	1	0
SPI 3 bit/pixel (8 colors); SPI 1-1-1 (Support IF: SPI3/SPI4)	0	1	1
16bit/pixel (65,536 colors)	1	0	1
18bit/pixel (262,144 colors)	1	1	0
24bit/pixel (16.7M colors)	1	1	1

RDDIM (0D00h): Read Display Image Mode

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	0D00h	D7	D6	D5	D4	D3	D2	D1	D0	00

Description	The display module returns the display image mode status. | Bit	Symbol	Description	Comment
---	---	---	---
D7	Reserved		'0'
D6	Reserved		'0'
D5	INVON	Inversion On/Off	"1" = Inversion is On, "0" = Inversion is Off
D4	ALLON	All Pixel On	'0' = Normal display '1' = White display
D3	ALLOFF	All Pixel Off	'0' = Normal display '1' = Black display
D2~D0	Reserved		'000'	

RDDSM (0E00h): Read Display Signal Mode

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	0E00h	D7	D6	D5	D4	D3	D2	D1	D0	00

Description	The display module returns the Display Signal Mode.				
	Bit	Symbol	Description	Comment	
	D7	TEON	Tearing Effect Line On/Off	"1" = On, "0" = Off	
	D6	TELOM	Tearing effect line mode	"0" = mode1, "1" = mode2	
	D5	Reserved		'0'	
	D4	Reserved		'0'	
	D3	Reserved		'0'	
	D2	Reserved		'0'	
	D1	Reserved		'0'	
	D0	Error on DSI	Error on DSI	'0' = No Error '1' = Error	

![Raydium logo]

RDDSDR (0F00h): Read Display Self-Diagnostic Result

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	0F00h	0	0	0	0	0	0	0	checksum_comp	00

Description	The display module returns the self-diagnostic results following a Sleep Out command.
	<table><tr><th>Bit</th><th>Symbol</th><th>Description</th><th>Comment</th></tr><tr><td>D0</td><td>Reserved</td><td>checksum_comp</td><td>'0'</td></tr></table>

SLPIN (1000h): Sleep In

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	1000h				No Argument					

Description	This command causes the display module to enter the minimum power consumption mode. In this mode the DC/DC converter is stopped, Internal display oscillator is stopped, and panel scanning is stopped. The control Interface such as registers is still working and keeps its values.
Restriction	This command has no effect when the display module is already in Sleep mode. Sleep In Mode can only be exit by the Sleep Out Command (11h). It must wait 5msec before sending next command for the supply voltages and clock circuits to stabilize. It must wait 120msec after sending Sleep Out command (when in Sleep In Mode) before Sleep In command can be sent.

SLPOUT (1100h): Sleep Out

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	1100h				No Argument					

Description	This command causes the display module to exit Sleep mode.
Restriction	This command shall not cause any visible effect on the display device when the display module is not in Sleep mode. The host processor must wait five milliseconds after sending this command before sending another command. This delay allows the supply voltages and clock circuits to stabilize. The host processor must wait 60 milliseconds after sending a Sleep Out command before sending a Sleep-In command. The display module loads the display module's default values to the registers when exiting the Sleep mode. There shall not be any abnormal visual effect on the display device when loading the registers if the factory default and register values are the same or when the display module is not in Sleep mode. The display module runs the self-diagnostic functions after this command is received.

PTLON (1200h): Partial Display Mode On

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	1200h	No Argument								

Description	This command causes the display module to enter the Partial Display Mode. The Partial Display Mode window is described by the Partial Area (30h) command. To leave Partial Display Mode, the Normal Display Mode On (13h) command should be written.
Restriction	This command has no effect when Partial Display Mode is already active.

NORON (1300h): Normal Display Mode On

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	1300h				No Argument					

Description	This command causes the display module to enter the Normal mode. Normal Mode is defined as Partial Display mode.
Restriction	This command has no effect when Normal Display mode is already active.
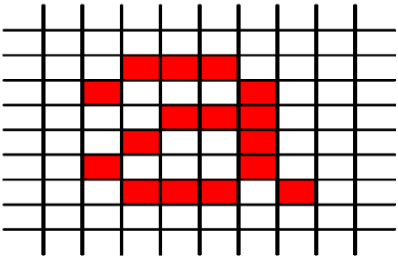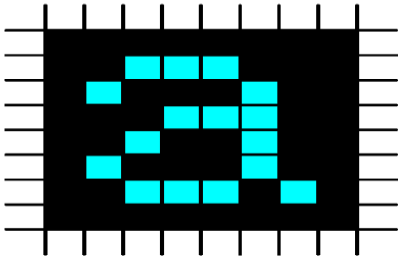
INVOFF (2000H): Display Inversion Off

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	2000h	No Argument								

Description	This command causes the display module to stop inverting the image data on the display device. No status bits are changed. **Input Image** **Display Panel**
Restriction	This command has no effect when the display module is not inverting the display image.
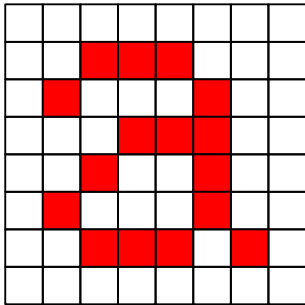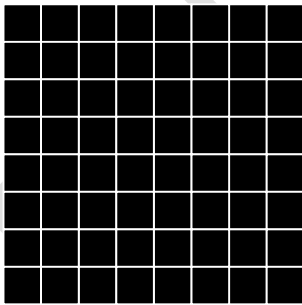
INVON (2100H): Display Inversion On

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	2100h				No Argument					

Description	This command causes the display module to invert the image data only on the display device. No status bits are changed. **Input Image** **Display Panel**
Restriction	This command has no effect when module is already in inversion on mode.
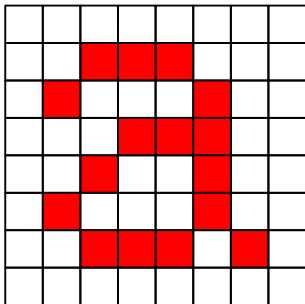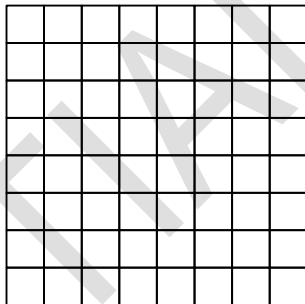
ALLPOFF (2200H): All Pixel Off

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	2200h				No Argument					

Description	This command turns the display panel black in Sleep Out mode and a status of the Display On/Off register can be on or off. This command does not change any other status. **Input Image** **Display Panel** "All Pixels On", "Normal Display Mode On" or "Partial Mode On" commands are used to leave this mode. The display panel is showing the content of the Input Image after "Normal Display On" and "Partial Mode On" commands.
Restriction	-
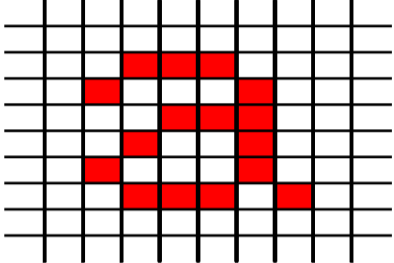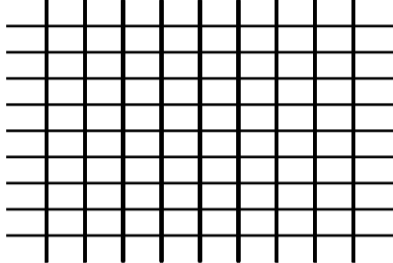
ALLPON (2300H): All Pixel On

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	2300h	No Argument								

Description	This command turns the display panel white in Sleep Out mode and a status of the Display On/Off register can be on or off. This command does not change any other status. **Input Image** **Display Panel** "All Pixels Off", "Normal Display Mode On" or "Partial Mode On" commands are used to leave this mode. The display panel is showing the content of the Input Image after "Normal Display On" and "Partial Mode On" commands.
Restriction	-

DISPOFF (2800h): Display Off
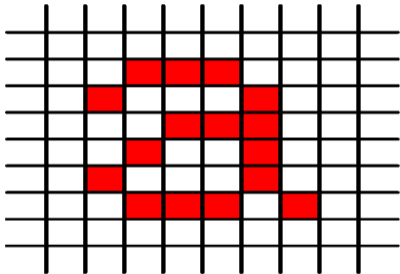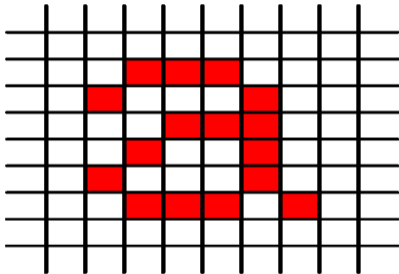
R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	2800h	No Argument								

Description	This command causes the display module to stop displaying the image data on the display device. No status bits are changed. **Input Image** → **Display Panel**
Restriction	This command has no effect when module is already in display off mode.
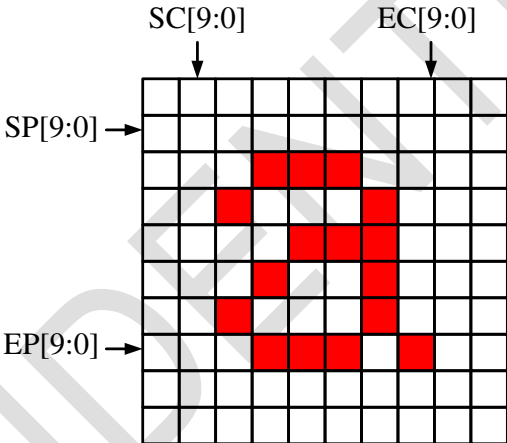
DISPON (2900h): Display On

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	2900h	No Argument								

Description	This command causes the display module to start displaying the image data on the display device. No status bits are changed. **Input Image** → **Display Panel**
Restriction	This command has no effect when module is already in display on mode.

CASET(2A00h~2A03h) : Set Column Start Address

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	2A00h	-	-	-	-	-	-	SC9	SC8	00
	2A01h	SC7	SC6	SC5	SC4	SC3	SC2	SC1	SC0	00
	2A02h	-	-	-	-	-	-	EC9	EC8	01
	2A03h	EC7	EC6	EC5	EC4	EC3	EC2	EC1	EC0	8F

Description	This command defines the column extent of the frame memory accessed by the host processor with the read_memory_continue and write_memory_continue commands. This command makes no change on the other driver status. The values of SC[9:0] and EC[9:0] are referred when RAMWR command comes. Each value represents one column line in the Frame Memory.
Restriction	(1) SC[9:0] always must be equal to or less than EC[9:0]. (2) The SC[9:0] and EC[9:0]-SC[9:0]+1 must can be divisible by 2.

RASET(2B00h~2B03h) : Set Row Start Address

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	2B00h	-	-	-	-	-	-	SP9	SP8	00
	2B01h	SP7	SP6	SP5	SP4	SP3	SP2	SP1	SP0	00
	2B02h	-	-	-	-	-	-	EP9	EP8	01
	2B03h	EP7	EP6	EP5	EP4	EP3	EP2	EP1	EP0	8F

Description	This command defines the page extent of the frame memory accessed by the host processor with the write_memory_continue and read_memory_continue command. This command makes no change on theother driver status. The values of SP[9:0] and EP[9:0] are referred when RAMWR command comes. Each value represents one Page line in the Frame Memory.
Restriction	(1) SP[9:0] always must be equal to or less than EP[9:0] (2) The SP[9:0] and EP[9:0]-SP[9:0]+1 must can be divisible by 2.
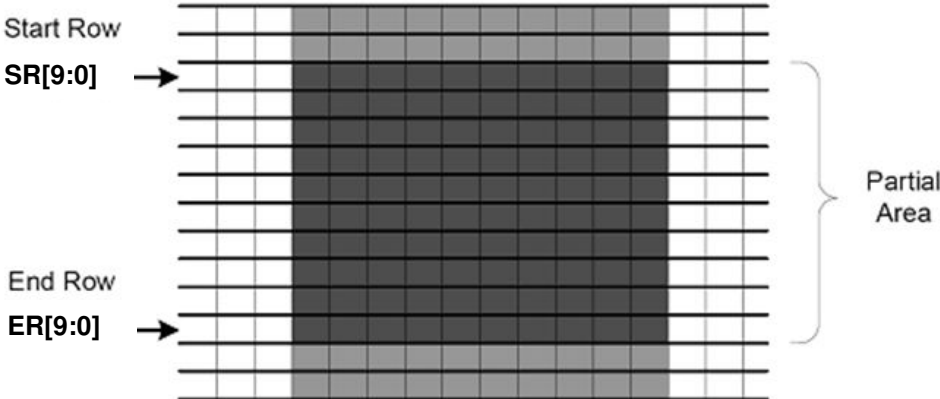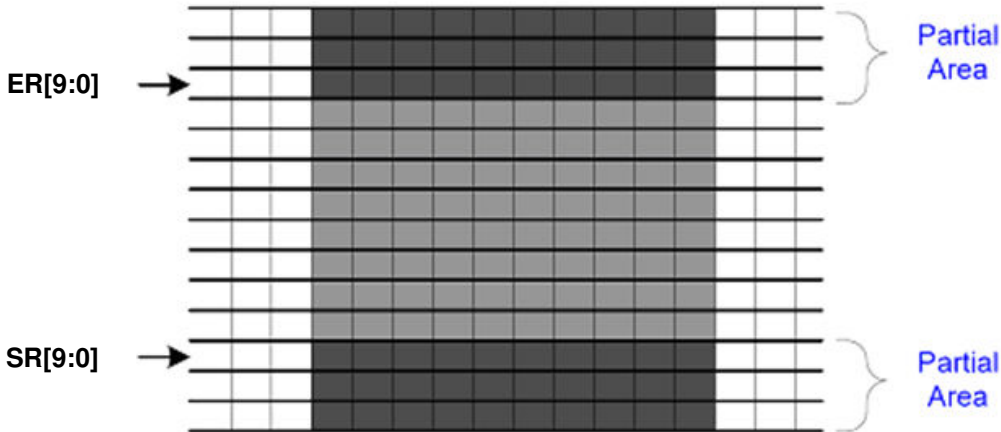
RAMWR (2C00h): Memory Write

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	2C00h	0	0	1	0	1	1	0	0	2C
	1st Pixel	$D_1 7$	$D_1 6$	$D_1 5$	$D_1 4$	$D_1 3$	$D_1 2$	$D_1 1$	$D_1 0$	
	:	:	:	:	:	:	:	:	:	
	Nth Pixel	$D_N 7$	$D_N 6$	$D_N 5$	$D_N 4$	$D_N 3$	$D_N 2$	$D_N 1$	$D_N 0$	

Description	This command transfers image data from the host processor to the display module's frame memory starting at the pixel location specified by preceding CASET (2Ah) and RASET (2Bh) commands.
Restriction	A Memory Write should follow a CASET(2Ah), RASET(2Bh) or MADCTR(36h) to define the write location. Otherwise, data written with RAMWR(2Ch) and any following RAMWRC(3Ch) commands is written to undefined locations.

PTLAR (3000h): Partial Area

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	3000h	-	-	-	-	-	-	SR9	SR8	00
	3001h	SR7	SR6	SR5	SR4	SR3	SR2	SR1	SR0	00
	3002h	-	-	-	-	-	-	ER9	ER8	01
	3003h	ER7	ER6	ER5	ER4	ER3	ER2	ER1	ER0	8F

Description	This command defines the Partial Display mode's display area. There are two parameters associated with this command, the first defines the Start Row (SR) and the second the End Row (ER), as illustrated in the following figure. If End Row > Start Row If End Row < Start Row If End Row = Start Row then the Partial Area will be one row deep.
Restriction	SR[9:0] and ER[9:0] settings should be within max available Display Area.

PTLAR (3100h): Vertical Partial Area

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	3100h	-	-	-	-	-	-	-	SC8	00
	3101h	SC7	SC6	SC5	SC4	SC3	SC2	SC1	SC0	00
	3102h	-	-	-	-	-	-	-	EC8	01
	3103h	EC7	EC6	EC5	EC4	EC3	EC2	EC1	EC0	8F

Description	This command defines the Vertical Partial Display mode's display area. There are two parameters associated with this command, the first defines the Start Column (SC) and the second the End Column (EC), as illustrated in the following figure. If End Column > Start Column Partial Area If End Column < Start Column
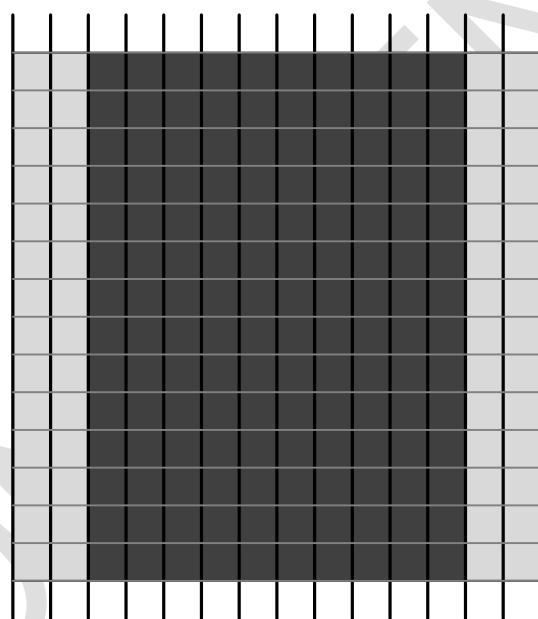
End Column
EC[9:0]

Start Column
SC[9:0]

Partial Area

Partial Area

If End Column = Start Column then the Partial Area will be one column deep.

Restriction	SC[9:0] and EC[9:0] settings should be within max available Display Area.

TEOFF (3400h): Tearing Effect Line OFF

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	3400h	No Argument								

Description	This command turns off the display module's Tearing Effect output signal on the TE signal line.
Restriction	This command has no effect when the Tearing Effect output is already off.

TEON (3500h): Tearing Effect Line ON

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	3500h	0	0	0	0	0	0]	TE_M	TELOM	00

Description		Bit / Symbol / Description / Comment table below

Bit	Symbol	Description	Comment
D1	TE_M	Output mode of TE signal set	1: Refresh frame active \<Note\> TE output active at refresh frame to avoid tearing effect, command can be set: 1. 0x3500=00.or 2. 0x3500=02.
D0	TELOM	Output mode of TE signal	0:only V-blanking 1:V-blanking +H-blanking

This command turns on the tearing Effect output signal on the TE signal line.
The Tearing Effect Line On has one parameter that describes the Tearing Effect Output Line mode.

If TELOM = 0:

The Tearing Effect Output line consists of V-Blanking information only.

tvdl   tvdh

Vertical Time Scale

If TELOM = 1:

The Tearing Effect Output Line consists of both V-Blanking and H-Blanking information.

tvdh tvdl

V-Sync   Invisible Line   1st Line   480th Line   V-Sync

The Tearing Effect Output line shall be active low when the display module is in Sleep mode.

Restriction	This command has no effect when Tearing Effect output is already ON.

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MADCTR (3600h): Scan Direction Control

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	3600h	D7	D6	D5	D4	D3	D2	D1	D0	00

Description	This command defines the scan direction of Source and Gate Driver. This command makes no change on the other driver status. | Bit	Symbol	Description	Comment
-----	--------	-------------	---------
D7	Reserved		
D6	MX	Column Address Increment	0: Increasing in horizontal 1: Decreasing in horizontal
D3	RGB	RGB/BGR Order	'1' =BGR, "0"=RGB
D2	Reserved		
D1	Reserved		
D0	Reserved			
Restriction	

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IDMOFF (3800h): Idle Mode Off

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	3800h				No Argument					

Description	This command causes the display module to exit Idle mode.
Restriction	This command has no effect when the display module is not in Idle mode.

IDMON (3900h): Enter_idle_mode

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	3900h	No Argument								

Description	This command causes the display module to enter Idle Mode.
Restriction	This command has no effect when module is already in idle on mode.

COLMOD (3A00h): Interface Pixel Format

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	3A00h	SPI_IFPF_SEL	VIPF[2]	VIPF[1]	VIPF[0]	0	IFPF[2]	IFPF[1]	IFPF[0]	77

Description	This command sets the pixel format for the RGB image data used by the interface. The IFPF[2:0] pixel format used by the MIPI/ MCU interface. If SPI_IFPF_SEL(3Ah-D7) = 1: The VIPF[2:0] pixel format used by the SPI interface If SPI_IFPF_SEL(3Ah-D7) = 0: The IFPF[2:0] pixel format used by the SPI interface _(table below)_ SPI 1-1-1 _(figure)_ SPI 3-3-2 _(figure)_ SPI 256 Gray _(figure)_
Restriction	-

Control Interface Color Format	IFPF[2]	IFPF[1]	IFPF[0]
SPI 8 bit/pixel (256 colors); SPI 256 Gray (Support IF: SPI3/SPI4)	0	0	1
SPI 8 bit/pixel (256 colors); SPI 3-3-2 (Support IF: SPI3/SPI4)	0	1	0
SPI 3 bit/pixel (8 colors); SPI 1-1-1 (Support IF: SPI3/SPI4)	0	1	1
16bit/pixel (65,536 colors)	1	0	1
18bit/pixel (262,144 colors)	1	1	0
24bit/pixel (16.7M colors)	1	1	1

SPI 1-1-1

RGB 1-1-1 Bit	DCX	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Note
CMDWR	0	0	0	0	0	0	0	0	0	0x2C for GRAM Write
1st RAM Data Write	1	X	X	R1[0]	G1[0]	B1[0]	R2[0]	G2[0]	B2[0]	1,2 pixel Data Write
2nd RAM Data Write	1	X	X	R3[0]	G3[0]	B3[0]	R4[0]	G4[0]	B4[0]	3,4 Data Write
3rd RAM Data Write	1	X	X	R5[0]	G5[0]	B5[0]	R6[0]	G6[0]	B6[0]	5,6 pixel Data Write
So on...										

SPI 3-3-2

RGB 3-3-2 Bit	DCX	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Note
CMDWR	0	0	0	0	0	0	0	0	0	0x2C for GRAM Write
1st RAM Data Write	1	R1[2]	R1[1]	R1[0]	G1[2]	G1[1]	G1[0]	B1[1]	B1[0]	1st pixel Data Write
2nd RAM Data Write	1	R2[2]	R2[1]	R2[0]	G2[2]	G2[1]	G2[0]	B2[1]	B2[0]	2nd pixel Data Write
3rd RAM Data Write	1	R3[2]	R3[1]	R3[0]	G3[2]	G3[1]	G3[0]	B3[1]	B3[0]	3rd pixel Data Write
So on...										

SPI 256 Gray

RGB 256 Gray	DCX	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Note
CMDWR	0	0	0	0	0	0	0	0	0	0x2C for GRAM Write
1st RAM Data Write	1	P1[7]	P1[6]	P1[5]	P1[4]	P1[3]	P1[2]	P1[1]	P1[0]	1st pixel Data Write
2nd RAM Data Write	1	P2[7]	P2[6]	P2[5]	P2[4]	P2[3]	P2[2]	P2[1]	P2[0]	2nd pixel Data Write
3rd RAM Data Write	1	P3[7]	P3[6]	P3[5]	P3[4]	P3[3]	P3[2]	P3[1]	P3[0]	3rd pixel Data Write
So on...										

RAMWRC (3C00h): Memory Continuous Write

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	3C00h	0	0	1	1	1	1	0	0	3C
	1st Pixel	D_17	D_16	D_15	D_14	D_13	D_12	D_11	D_10	
	:	:	:	:	:	:	:	:	:	
	Nth Pixel	D_N7	D_N6	D_N5	D_N4	D_N3	D_N2	D_N1	D_N0	

Description	This command transfers image data from the host processor to the display module's frame memory continuing from the pixel location following the previous write_memory_continue or write_memory_start command.
Restriction	A Memory Write should follow a CASET(2Ah), RASET(2Bh) or MADCTR(36h) to define the write location. Otherwise, data written with RAMWR(2Ch) and any following RAMWRC(3Ch) commands is written to undefined locations.

STESL(4400h) : Set_Tear_Scanline

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	4400h	STS[15]	STS[14]	STS[13]	STS[12]	STS[11]	STS[10]	STS[9]	STS[8]	00
	4401h	STS[7]	STS[6]	STS[5]	STS[4]	STS[3]	STS[2]	STS[1]	STS[0]	00

Description	This command turns on the display Tearing Effect output signal on the TE signal line when the display reaches line N. The TE signal is not affected by changing set_address_mode bit B4. The Tearing Effect Line On has one parameter that describes the Tearing Effect Output Line mode. The Tearing Effect Output line shall be active low when the display module is in Sleep mode.
Restriction	

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GSL (4500h) : Get_Scanline

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	4500h	GTS[15]	GTS[14]	GTS[13]	GTS[12]	GTS[11]	GTS[10]	GTS[9]	GTS[8]	0x
	4501h	GTS[7]	GTS[6]	GTS[5]	GTS[4]	GTS[3]	GTS[2]	GTS[1]	GTS[0]	xx

Description	The display returns the current scan line, N, used to update the display device. The total number of scan lines on a display device is defined as VSYNC + VBP + VACT + VFP. The first scan line is defined as the first line of V-Sync and is denoted as Line 0. When in Sleep Mode, the value returned by get scanline is undefined.
Restriction	-

DSTBON (4F00h): Deep Standby Mode On

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	4F00h	0	0	0	0	0	0	0	DSTB	00

Description	This command is used to enter deep standby mode. DSTB="1", enter deep standby mode. Notes: 1. To exit Deep Standby Mode, input low pulse more than 3 msec to pin RESX. 2. For MIPI IF, if deep standby mode is used, please pull HSSI_CLK_P/N & HSSI_D0~D1_P/N to GND after executing deep standby command.
Restriction	-

WRDISBV (5100h): Write Display Brightness

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	5100h	DBV7	DBV6	DBV5	DBV4	DBV3	DBV2	DBV1	DBV0	00

Description	This command is used to adjust brightness value. In principle relationship is that 00h value means the lowest brightness and FFh value means the highest brightness.
Restriction	The display supplier cannot use this command for tuning

RDDISBV (5200h): Read Display Brightness

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	5200h	DBV7	DBV6	DBV5	DBV4	DBV3	DBV2	DBV1	DBV0	00

Description	This command returns brightness value. In principle relationship is that 00h value means the lowest brightness and FFh value means the highest brightness.
Restriction	-

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WRCTRLD (5300h): Write Display Control

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	5300h	0	0	BCTRL	0	DD	0	0	0	28

Description	BCTRL: Brightness control ,1=enable DD: Display dimming control ,1=enable
Restriction	The display supplier cannot use this command for tuning

RDCTRLD (5400h): Read Display Control

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	5400h	0	0	BCTRL	0	DD	0	0	0	28

Description	BCTRL: Brightness control ,1=enable DD: Display dimming control ,1=enable
Restriction	-

WRRADACL (5500h): RAD_ACL Control

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	5500h	0	0	0	0	0	0	RAD_ACL[1:0]		00

Description	This command is used to control Raydium specific function for ACL (Auto Current Limit) RAD_ACL[1:0]=11, Enable Raydium ACL function. RAD_ACL[1:0]=00, Disable Raydium ACL function.
Restriction	-

IMGEHCCTR (5800h) : Set_color_enhance

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	5800h	0	0	0	0	0	SLR_EN	SLR_LEVEL1	SLR_LEVEL0	00

Description	Bit	Description	Value
	SLR_EN	Sunlight Readable Enhancement Enable	'0' : disable; '1': enable
	SLR_LEVEL[1:0]	Sunlight Readable Enhancement Level	0~2, low to high
Restriction	-		

IMGEHCCTR (5900h) : Read_color_enhance

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	5900h	0	0	0	0	0	SLR_EN	SLR_LEVEL1	SLR_LEVEL0	00

Description	Bit	Description	Value
	SLR_EN	Sunlight Readable Enhancement Enable	'0' : disable; '1': enable
	SLR_LEVEL[1:0]	Sunlight Readable Enhancement Level	0~2, low to high
Restriction	-		

WRDISBV (6300h): Write HBM Display Brightness

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	6300h				DBV_HBM[7:0]					00

Description	This command is used to adjust brightness value in HBM mode if hbm_gidx_type=1.(0xC840h)
Restriction	1. The display supplier cannot use this command for tuning 2. DBV_HBM[7:0] setting value must be greater than G_ratio_to2 (0xAC60h)/ G_ratio_to3 (0x5530h) value.

RDDISBV (6400h): Read HBM Display Brightness

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	6400h	DBV_HBM[7:0]								00

Description	This command returns brightness value in HBM mode.
Restriction	-

HBM_Mode (6600h) : Set_HBM_Mode

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	6600h	0	0	0	0	0	0	HBM_en	0	00

Description	HBM_en = 1, This command causes the display module to enter HBM mode (exit normal, idle and deep idle) HBM_en = 0, This command causes the display module to exit HBM mode (to normal mode)
Restriction	under display area

Deep_Idle_Mode (6700h) : Set_Deep Idle Mode

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	6700h	0	0	0	0	0	0	0	DEEP_IDLE_EN	00

Description	Deep_Idle_en = 1, This command causes the display module to enter deep idle mode (exit normal, idle and HBM) Deep_Idle_en = 0, This command causes the display module to exit deep idle mode (to idle mode)
Restriction	under display area

COLSET (7000~7F00h): Interface Pixel Format Set

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	7000h				R_0000[7:0]					00
	7001h				G_0000[7:0]					00
	7002h				B_0000[7:0]					00
W	7100h				R_0001[7:0]					00
	7101h				G_0001[7:0]					00
	7102h				B_0001[7:0]					FF
W	7200h				R_0010[7:0]					00
	7201h				G_0010[7:0]					FF
	7202h				B_0010[7:0]					00
W	7300h				R_0011[7:0]					00
	7301h				G_0011[7:0]					FF
	7302h				B_0011[7:0]					FF
W	7400h				R_0100[7:0]					FF
	7401h				G_0100[7:0]					00
	7402h				B_0100[7:0]					00
W	7500h				R_0101[7:0]					FF
	7501h				G_0101[7:0]					00
	7502h				B_0101[7:0]					FF
W	7600h				R_0110[7:0]					FF
	7601h				G_0110[7:0]					FF
	7602h				B_0110[7:0]					00
W	7700h				R_0111[7:0]					FF
	7701h				G_0111[7:0]					FF
	7702h				B_0111[7:0]					FF
W	7800h				R_1000[7:0]					00
	7801h				G_1000[7:0]					00
	7802h				B_1000[7:0]					00
W	7900h				R_1001[7:0]					00
	7901h				G_1001[7:0]					00
	7902h				B_1001[7:0]					FF
W	7A00h				R_1010[7:0]					00
	7A01h				G_1010[7:0]					FF
	7A02h				B_1010[7:0]					00
W	7B00h				R_1011[7:0]					00
	7B01h				G_1011[7:0]					FF
	7B02h				B_1011[7:0]					FF
W	7C00h				R_1100[7:0]					FF
	7C01h				G_1100[7:0]					00
	7C02h				B_1100[7:0]					00
W	7D00h				R_1101[7:0]					FF
	7D01h				G_1101[7:0]					00
	7D02h				B_1101[7:0]					FF
W	7E00h				R_1110[7:0]					FF

	7E01h	G_1110[7:0]	FF
	7E02h	B_1110[7:0]	00
W	7F00h	R_1111[7:0]	FF
	7F01h	G_1111[7:0]	FF
	7F02h	B_1111[7:0]	FF

Description	This command set the 1-1-1 color format map directly to 24 bits by CMD 7000h-7F00h

RGB111 color mapping	R[7:0]	G[7:0]	B[7:0]
0000 (70h)	R_0000[7:0]	G_0000[7:0]	B_0000[7:0]
0001 (71h)	R_0001[7:0]	G_0001[7:0]	B_0001[7:0]
0010 (72h)	R_0010[7:0]	G_0010[7:0]	B_0010[7:0]
0011 (73h)	R_0011[7:0]	G_0011[7:0]	B_0011[7:0]
0100 (74h)	R_0100[7:0]	G_0100[7:0]	B_0100[7:0]
0101 (75h)	R_0101[7:0]	G_0101[7:0]	B_0101[7:0]
0110 (76h)	R_0110[7:0]	G_0110[7:0]	B_0110[7:0]
0111 (77h)	R_0111[7:0]	G_0111[7:0]	B_0111[7:0]
1000 (78h)	R_1000[7:0]	G_1000[7:0]	B_1000[7:0]
1001 (79h)	R_1001[7:0]	G_1001[7:0]	B_1001[7:0]
1010 (7Ah)	R_1010[7:0]	G_1010[7:0]	B_1010[7:0]
1011 (7Bh)	R_1011[7:0]	G_1011[7:0]	B_1011[7:0]
1100 (7Ch)	R_1100[7:0]	G_1100[7:0]	B_1100[7:0]
1101 (7Dh)	R_1101[7:0]	G_1101[7:0]	B_1101[7:0]
1110 (7Eh)	R_1110[7:0]	G_1110[7:0]	B_1110[7:0]
1111 (7Fh)	R_1111[7:0]	G_1111[7:0]	B_1111[7:0]

Restriction	

COLOPT (8000h): Interface Pixel Format Option

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	8000h	x	RGB111_opt	x	x	RGB4bit_en	gray256_color[2]	gray256_color[1]	gray256_color[0]	07

Description	This command sets the 1-1-1/256 gray color format option used by SPI interface. RGB111_opt = 0 (80h-B6): Supporting in IFPF[2:0]=011 case setting by 3A00h (interface pixel format is SPI 1-1-1). RGB111_opt = 1 (80h-B6): Supporting in IFPF[2:0]=011 case setting by 3A00h (interface pixel format is SPI 1-1-1). RGB4bit_en = 0 (80h-B3): Supporting in IFPF[2:0]=011 case setting by 3A00h (interface pixel format is SPI 1-1-1). Three bits per pixel formats map directly to 24bits by CMD 7000h-7700h Example: P1[2:0] = 3'b101 = { R_0101[7:0], G_0101[7:0], B_0101[7:0] } CMD 7500h-7502h

RGB111_opt = 0 (80h-B6):
Supporting in IFPF[2:0]=011 case setting by 3A00h (interface pixel format is SPI 1-1-1).

RGB 1-1-1 Bit	DCX	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Note
CMDWR	0	0	0	0	0	0	0	0	0	0x2C for GRAM Write
1st RAM Data Write	1	X	X	R1[0]	G1[0]	B1[0]	R2[0]	G2[0]	B2[0]	1,2 pixel Data Write
2nd RAM Data Write	1	X	X	R3[0]	G3[0]	B3[0]	R4[0]	G4[0]	B4[0]	3,4 pixel Data Write
3rd RAM Data Write	1	X	X	R5[0]	G5[0]	B5[0]	R6[0]	G6[0]	B6[0]	5,6 pixel Data Write
So on...										

RGB111_opt = 1 (80h-B6):
Supporting in IFPF[2:0]=011 case setting by 3A00h (interface pixel format is SPI 1-1-1).

RGB 1-1-1 Bit	DCX	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Note
CMDWR	0	0	0	0	0	0	0	0	0	0x2C for GRAM Write
1st RAM Data Write	1	x	R1[0]	G1[0]	B1[0]	x	R2[0]	G2[0]	B2[0]	1,2 Pixel Data Write
2nd RAM Data Write	1	x	R3[0]	G3[0]	B3[0]	x	R4[0]	G4[0]	B4[0]	3,4 Pixel Data Write
3rd RAM Data Write	1	x	R5[0]	G5[0]	B5[0]	x	R6[0]	G6[0]	B6[0]	5,6 Pixel Data Write
So on...										

RGB4bit_en = 0 (80h-B3):
Supporting in IFPF[2:0]=011 case setting by 3A00h (interface pixel format is SPI 1-1-1).
Three bits per pixel formats map directly to 24bits by CMD 7000h-7700h

RGB 1-1-1 Bit	DCX	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Note
CMDWR	0	0	0	0	0	0	0	0	0	0x2C for GRAM Write
1st RAM Data Write	1	x	x	P1[2]	P1[1]	P1[0]	P2[2]	P2[1]	P2[0]	1,2 Pixel Data Write
2nd RAM Data Write	1	x	x	P3[2]	P3[1]	P3[0]	P4[2]	P4[1]	P4[0]	3,4 Pixel Data Write
3rd RAM Data Write	1	x	x	P5[2]	P5[1]	P5[0]	P6[2]	P6[1]	P6[0]	5,6 Pixel Data Write
So on...										

Example:
P1[2:0] = 3'b101 = { R_0101[7:0], G_0101[7:0], B_0101[7:0] }   CMD 7500h-7502h

Description

RGB4bit_en = 1(80h-B3):
Supporting in IFPF[2:0]=011 case setting by 3A00h (interface pixel format is SPI 1-1-1).
Four bits per pixel formats map directly to 24bits by CMD 7000h-7F00h

RGB 1-1-1 Bit	DCX	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Note
CMDWR	0	0	0	0	0	0	0	0	0	0x2C for GRAM Write
1st RAM Data Write	1	P1[3]	P1[2]	P1[1]	P1[0]	P2[3]	P2[2]	P2[1]	P2[0]	1,2 Pixel Data Write
2nd RAM Data Write	1	P3[3]	P3[2]	P3[1]	P3[0]	P4[3]	P4[2]	P4[1]	P4[0]	3,4 Pixel Data Write
3rd RAM Data Write	1	P5[3]	P5[2]	P5[1]	P5[0]	P6[3]	P6[2]	P6[1]	P6[0]	5,6 Pixel Data Write
So on…										

Example:
P1[3:0] = 4'b1101 = { R_1101[7:0], G_1101[7:0], B_1101[7:0] }   CMD 7D00h-7D02h

gray256_color(80h-B[2:0]):
Supporting in IFPF[2:0]=001 case setting by 3A00h (interface pixel format is SPI 256 Gray).
This command sets the valid red, green and blue 256 grayscale

gray256_color[2:0]	Red grayscale	Green grayscale	Blue grayscale
000	00000000	00000000	00000000
001	00000000	00000000	P[7:0]
010	00000000	P[7:0]	00000000
011	00000000	P[7:0]	P[7:0]
100	P[7:0]	00000000	00000000
101	P[7:0]	00000000	P[7:0]
110	P[7:0]	P[7:0]	00000000
111	P[7:0]	P[7:0]	P[7:0]

Restriction
-

RDDDBS(A100h) : Read_DDB_Start

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	A100h	SID[7]	SID [6]	SID [5]	SID [4]	SID [3]	SID [2]	SID [1]	SID [0]	D0
	A101h	SID[15]	SID[14]	SID[13]	SID[12]	SID[11]	SID[10]	SID[9]	SID[8]	01
	A102h	MID[7]	MID[6]	MID[5]	MID[4]	MID[3]	MID[2]	MID[1]	MID[0]	80
	A103h	MID[15]	MID[14]	MID[13]	MID[12]	MID[11]	MID[10]	MID[9]	MID[8]	90
	A104h	1	1	1	1	1	1	1	1	FF

Description	1st parameter: Supplier ID code 2nd parameter: Supplier ID code 3rd parameter: Module ID 4th parameter: Module ID 5th Exit code (FFh).
Restriction	

RDDDBC(A800h) : Read DDB Continous

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	A800h	SID[7]	SID [6]	SID [5]	SID [4]	SID [3]	SID [2]	SID [1]	SID [0]	D0
	A801h	SID[15]	SID[14]	SID[13]	SID[12]	SID[11]	SID[10]	SID[9]	SID[8]	01
	A802h	MID[7]	MID[6]	MID[5]	MID[4]	MID[3]	MID[2]	MID[1]	MID[0]	80
	A803h	MID[15]	MID[14]	MID[13]	MID[12]	MID[11]	MID[10]	MID[9]	MID[8]	90
	A804h	1	1	1	1	1	1	1	1	FF

Description	This command returns the supplier identification and display module mode/revision information from the point where RDDDBS command was interrupted by an other command. *Note: Parameter 0xFF is an "Exit Code", this means that there is no more data in the DDB block.* *Note: For use example,* *1. Set maximum return packet size=3* *2. Read 0xA1, return 3 bytes SID[7:0], SID[15:8], MID[7:0]* *3. Read 0xA8, return 2 bytes MID[15:8],RID[7:0], RID[15:8] and 0xFF*
Restriction	A Read DDB Start command (RDDDBS) should be executed at least once before a Read DDB Continue command (RDDDBC) to define the read location. Otherwise, data read with a Read DDB Continue c ommnd is undefined.

RDFCS(AA00h) : Read First Checksum

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	AA00h	FCS7	FCS6	FCS5	FCS4	FCS3	FCS2	FCS1	FCS0	00

Description	This command returns the first checksum what has been calculated from "User Command Set" area registers (not include "Manufacture Command Set) and the frame memory after the write access to those registers and/or frame memory has been done.
Restriction	It will be necessary to wait 150ms after there is the last write access on "User Command Set" area registers before there can read this checksum value.

RDCCS(AF00h) : Read Continue Checksum

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	AF00h	CCS7	CCS6	CCS5	CCS4	CCS3	CCS2	CCS1	CCS0	00

Description	This command returns the continue checksum what has been calculated continuously after the first checksum has calculated from "User Command Set" area registers and the frame memory after the write access to those registers and/or frame memory has been done.
Restriction	It will be necessary to wait 300ms after there is the last write access on "User Command Set" area registers before there can read this checksum value in the first time.

SetDISPMode (C200h) : set_DISP Mode

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	C200h	0	0	0	0	0	0	DM1	DM0	00

Description	Bit	Description	Value
	DM[1:0]	Display timing mode selection	2'b00: internal timing 2'b01: reserved 2'b10: reserved 2'b11: external timing (VSYNC + HSYNC align mode)
Restriction	Note: (1) If video mode, need to set DM[1:0] = 2'b11. (2) System video mode parameter V-total and H-total setting has restriction, it must match driver IC V-total and H-total setting. Related video mode parameter settings suggest asking Raydium.		

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SetDSPIMode (C400h) : set_DSPI Mode

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	C400h	SPI_WRAM	0	DSPI_CFG 1	DSPI_CFG 0	0	0	0	DSPI_EN	00

Description	**Bit**	**Description**	**Value**
	DSPI_EN	DAUL SPI MODE Enable	0: disable 1: enable
	DSPI_CFG[1:0]	DAUL SPI MODE Selection	00: 1P1T for 1 wire 10: 1P1T for 2 wire 11: 2P3T for 2 wire 01: reserved
	SPI_WRAM	This command is used in SPI/SPINK interfaces. Making sure to set SPI_WRAM=1 before host writes SRAM via SPI/SPINK interfaces.	0: disable 1: SPI interface write RAM enable
	Note: detailed DAUL SPI formats are described at next page.		
Restriction			

DUAL SPI via SPI3 interface :
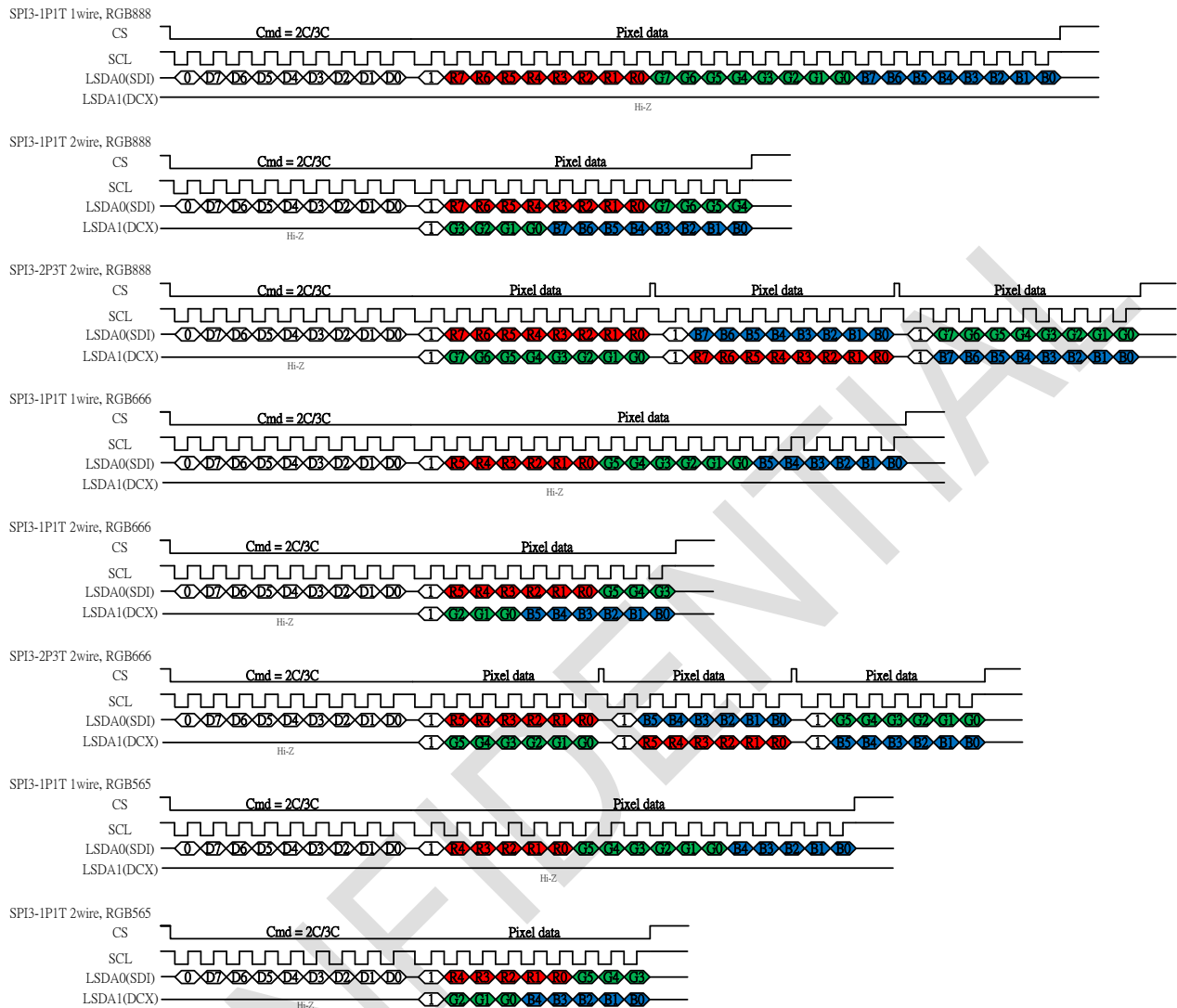
DUAL SPI via SPI4 interface :
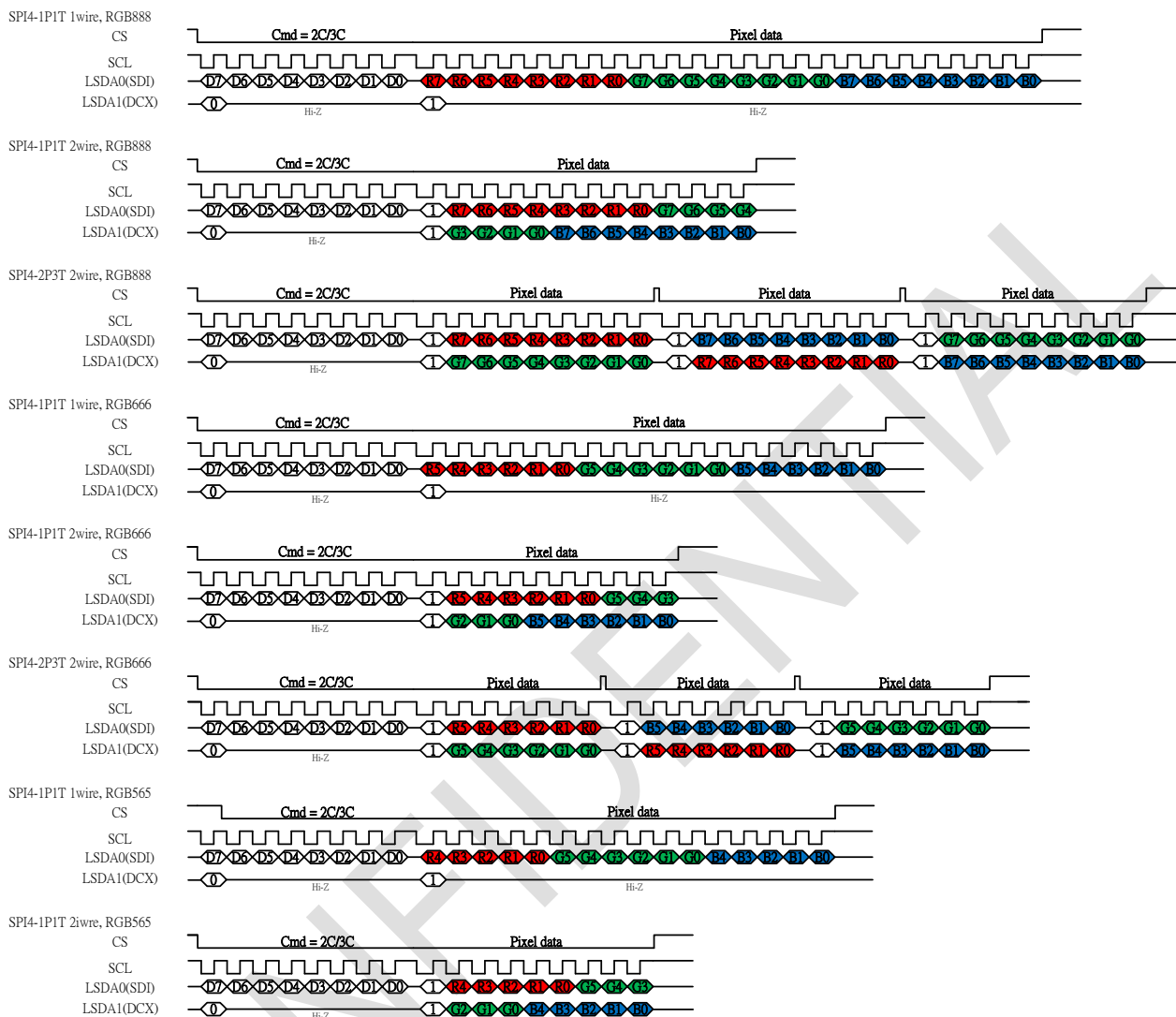
RDID1 (DA00h): ID1 Code

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	DA00h	ID1[7:0]								00h

Description	This command is for Module Manufacture Number
	<table><tr><td>Bit</td><td>Description</td><td>Data</td></tr><tr><td>ID1[7:0]</td><td>Module Manufactor Number</td><td></td></tr></table>
Restriction	

RDID2 (DB00h): ID2 Code

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	DB00h				ID2[7:0]					80h

Description	This command is for Module/Driver Version Number | Bit	Description	Data
-----	-------------	------
ID2[7:0]	Module/Driver Version Number		
Restriction	

RDID3 (DC00h): ID3 Code

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	DC00h				ID3[7:0]					00h

Description	This command is for Module / Driver ID | Bit	Description	Data
-----	-------------	------
ID3[7:0]	Module /Driver ID		
Restriction	

(FE00h): CMD Mode Switch

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
W	FE00h	-	-	-	-		CMD_Page[3:0]			00

Description	This command is used to switch the Manufacture Command Pages and User Commands sets. | CMD_Page[3:0]	Hex Value	Description
---------------	-----------	-------------
0000	00h (default)	User Command Set (UCS = CMD1)
0001	01h	Manufacture Command Set Page0
1100	0Ch	Manufacture Command Set Page0 extension
1011	0Bh	Manufacture Command Set Page Panel ID
0010	02h	Manufacture Command Set Page Gamma1
0011	03h	Manufacture Command Set Page Gamma2
1101	0Dh	Manufacture Command Set Page Gamma3
0100	04h	Manufacture Command Set Page VSR
0110	06h	Manufacture Command Set Page DBC	
Restriction	-

(FF00h): Read CMD Status

R/W	Address	D7	D6	D5	D4	D3	D2	D1	D0	HEX
R	FF00h	-	-	-	-	CMD_Status[3:0]				00

Description	This command is used to switch the Manufacture Command Pages and User Commands sets. <table><tr><td>CMD_Status[3:0]</td><td>Hex Value</td><td>Description</td></tr><tr><td>0000</td><td>00h (default)</td><td>User Command Set (UCS = CMD1)</td></tr><tr><td>0001</td><td>01h</td><td>Manufacture Command Set Page0</td></tr><tr><td>1100</td><td>0Ch</td><td>Manufacture Command Set Page0 extension</td></tr><tr><td>1011</td><td>0Bh</td><td>Manufacture Command Set Page Panel ID</td></tr><tr><td>0010</td><td>02h</td><td>Manufacture Command Set Page Gamma1</td></tr><tr><td>0011</td><td>03h</td><td>Manufacture Command Set Page Gamma2</td></tr><tr><td>1101</td><td>0Dh</td><td>Manufacture Command Set Page Gamma3</td></tr><tr><td>0100</td><td>04h</td><td>Manufacture Command Set Page VSR</td></tr><tr><td>0110</td><td>06h</td><td>Manufacture Command Set Page DBC</td></tr></table>
Restriction	-

7. Electrical Characteristics

7.1 Absolute Maximum Ratings

The absolute maximum rating is listed on following table. When RM69090 is used out of the absolute maximum ratings, the RM69090 may be permanently damaged. To use the RM69090 within the following electrical characteristics limit is strongly recommended for normal operation. If these electrical characteristic conditions are exceeded during normal operation, the RM69090 will malfunction and cause poor reliability.

item	Symbol	Value	Unit
Power supply voltage	VDDI	-0.3 ~ + 5.5	V
Power supply voltage	VDD (VDDA, VDDB, VDDR)	-0.3 ~ + 5.5	V
Supply voltage (MV)	AVDD- AVSS	-0.3 ~ + 6.6	V
	AVSS- VCL	-0.3 ~ + 5.0	V
Supply voltage (HV)	VGH- VGLX	-0.3 ~ + 33	V
Input voltage	VIN	-0.3 ~ VDDI+ 0.3	V
Output voltage	VO	-0.3 ~ VDDI+ 0.3	V
Operating temperature	Topr	-40 ~ + 85	°C
Storage temperature	Tstg	-55 ~ + 125	°C
Notes: If one of the above items is exceeded its maximum limitation momentarily, the quality of the product may be degraded. Absolute maximum limitation. Therefore, specify the values exceeding which the product may be physically damaged. Be sure to use the product within the recommend range.			

7.2 ESD Protection Level

Model	Test Condition	Level
Human Body Mode	R = 1.5 kohm / C = 100 pF	Pass 3KV
Machine Mode	R = 0 ohm / C = 200 pF	Pass 300V

7.3 Latch-Up Protection Level

The device will not latch up at trigger current levels less than ±200 mA.

7.4 DC Characteristics

7.4.1   Basic Characteristics

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	Related Pins
Analog Power Supply Voltage	VDD	Operation Voltage	2.7	2.8	3.6	V	Note 1
I/O pin Power Supply Voltage	VDDI	I/O supply voltage	1.65	1.8	3.3	V	Note 1,2
Logic High level input voltage	VIH	VDDI = 1.65V ~ 3.3V	0.8* VDDI	-	VDDI	V	Note 3
Logic Low level input voltage	VIL	VDDI = 1.65V ~ 3.3V	0.0	-	0.2* VDDI	V	Note 3
Logic High level Output voltage	VOH	Iout = -1 mA	0.8* VDDI	-	VDDI	V	Note 3
Logic Low level Output voltage	VOL	Iout = +1 mA	0.0	-	0.2* VDDI	V	Note 3
Logic High level input current (Except MIPI)	IIHD	Vin=0~VDDI			1	uA	Note 3
Logic Low level input current (Except MIPI)	IILD	Vin=0~VDDI	-1			uA	Note 3
Logic High level input current (MIPI)	IIHD	Vin=0~VDDI			1	uA	Note 3
Logic Low level input current (MIPI)	IILD	Vin=0~VDDI	-1			uA	Note 3
AVDD booster voltage	AVDD		4.5		6.5	V	Note 3
VCL booster voltage	VCL		-3.5		-5	V	Note 3
VGH booster voltage	VGH		AVDD		2AVDD	V	Note 3
VGL booster voltage	VGL		VCL		VCL -AVDD	V	Note 3
Voltage difference between VGH and VGL	VGHL	|VGH-VGL|			30	V	Note 3
Gamma reference voltage	VGMP		2.0		6.0	V	Note 3,4
Gamma reference voltage	VGSP		0.0		4.5	V	Note 3
OSC	Fosc		20.24	22	23.76	MHz	
Channel deviation voltage	V$_{DEV}$	Sout ≥ AVDD-1.0V, and 0V < Sout ≤ 1.0V				mV	TBD
Channel deviation voltage	V$_{DEV}$	1.0V < Sout < AVDD-1.0V				mV	TBD

Notes:
1. VDD means VDDA, VDDR, VDDB.   And VSS means VSSA, VSSR, VSSB, AVSS, VSSAM.   VDDB, VDDA and VDDR should be the same input voltage level and larger than VDDI voltage.
2. Recommend VDDI=1.8V for power saving.
3. Ta(ambient temperature) ranges from -30℃ to 85 ℃.
4. VGMP <= AVDD – 0.5V

7.4.2 Operation current

VCI=2.8V and VDDI=1.8V

Parameter	Symbol	Condition	Max.	Unit
Sleep In Mode	I_SLP_VCI	VDDI=VCC=1.8V VCI=VDDA=VDDB=VDDR=2.8V	50	uA
	I_SLP_VDDI	HSSI_D0P/N=HSSI_D1P/N=HSSI_CKP/N=LP-11 Ta = 25deg	180	uA
Deep Standby Mode	I_DSTB_VCI	VDDI=VCC=1.8V VCI=VDDA=VDDB=VDDR=2.8V	4	uA
	I_DSTB_VDDI	HSSI_D0P/N=HSSI_D1P/N=HSSI_CKP/N=0 Ta = 25deg	1	uA

7.5 MIPI Characteristics

7.5.1 High-Speed Receiver Specification

DC Specifications

High Speed Receiver
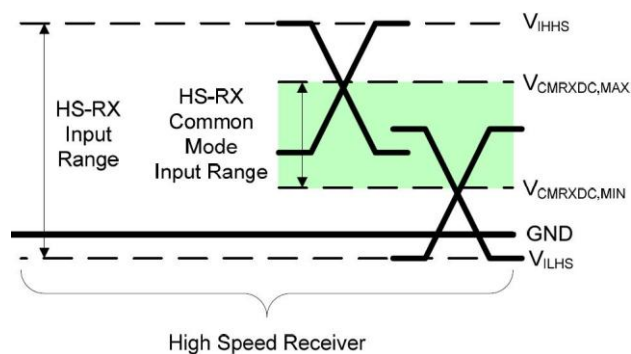
Parameter	Description	Min	Nom	Max	Units	Note
VCMRX(DC)	Common-mode voltage HS receive mode	70		330	mV	1,2
VIDTH	Differential input high threshold			70	mV	
VIDTL	Differential input low threshold	-70			mV	
VIHHS	Single-ended input high voltage			460	mV	1
VILHS	Single-ended input low voltage	-40			mV	1
ZID	Differential input impedance	80	100	125	Ω	

Notes:
1. Excluding possible additional RF interference of 100mV peak sine wave beyond 450MHz.
2. This table value includes a ground difference of 50mV between the transmitter and the receiver, the static common-mode level tolerance and variations below 450MHz

7.5.2 Forward high speed transmissions

DDR Clock Definition
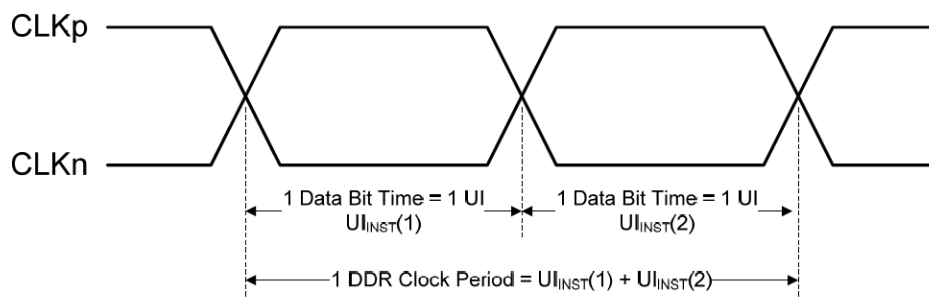
Clock Parameter	Symbol	Min	Typ	Max	Units	Notes
UI instantaneous	UI_{INST}	2		12.5	ns	1,2

Notes:
1. This value corresponds to a minimum 80 Mbps data rate.
2. The minimum UI shall not be violated for any single bit period, i.e., any DDR half cycle within a data burst.

Data-Clock Timing Specifications

Parameter	Symbol	Min	Typ	Max	Units	Notes
Data to Clock Skew [measured at transmitter]	$T_{SKEW[TX]}$	-0.15		0.15	UI_{INST}	1
Data to Clock Setup Time [receiver]	$T_{SETUP[RX]}$	0.15			UI_{INST}	2
Clock to Data Hold Time [receiver]	$T_{HOLD[RX]}$	0.15			UI_{INST}	2

Notes:
1. Total silicon and package delay budget of $0.3*UI_{INST}$
2. Total setup and hold window for receiver of 0.3*UIINST

7.5.3 Data to Clock Timing Definitions
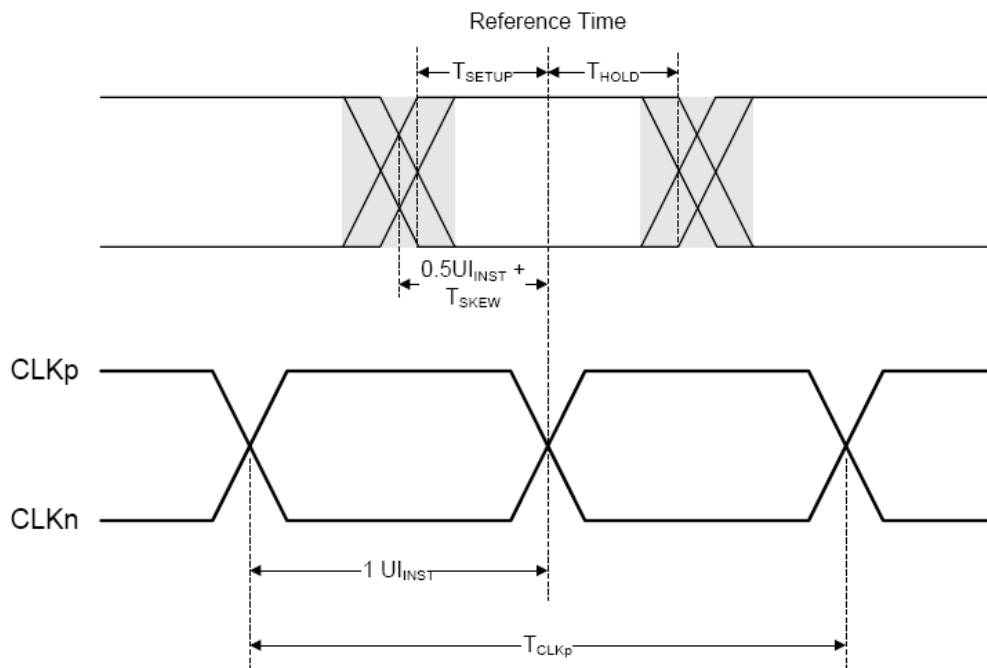
7.5.4 Low power transceiver specifications

Parameters	Symbol	Condition	Min	Typ	Max	Unit
Logic high level input voltage	VIHCD	Contention Detection (Lane_D0)	450		1350	mV
Logic low level input voltage	VILCD	Contention Detection (Lane_D0)	0		200	mV
Logic high level input voltage	VIH-LPRX	LP-Rx (Lane_CK, Lane_D0, Lane_D1)	880	-	1350	mV
Logic low level input voltage	VIL-LPRX	LP-Rx (Lane_CK, Lane_D0, Lane_D1	0		550	mV
Logic low level input voltage	VIL-ULPS	LP-Rx ULPS (Lane_CK, Lane_D0, Lane_D1)	0		300	mV
Logic high level input voltage	VOH-LPTX	Contention Detection (Lane_D0)	1.1	1.2	1.3	V
Logic low level input voltage	VOL-LPTX	Contention Detection (Lane_D0)	-50	0	50	mV
eSPIKE[1.2.3]	Fig. 2	Input pulse rejection			300	V.ps

Notes:

Time-voltage integration of a spike above VIL when being in LP-0 state or below VIH when being in LP-1 State. An impulse less than this will not change the receiver state.

In addition to the required glitch rejection, implementers shall ensure rejection of known RF-interferers.

Input Glitch Rejection of Low Power Receivers as follow.
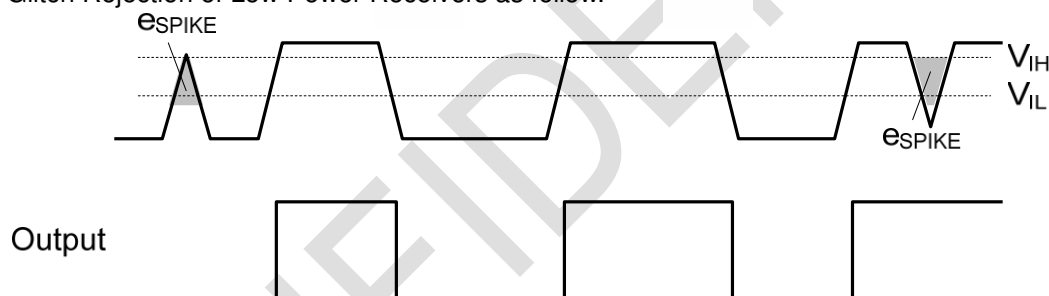
7.6 AC Characteristics

7.6.1 Serial Interface Characteristics

SPI Serial Interface Characteristics
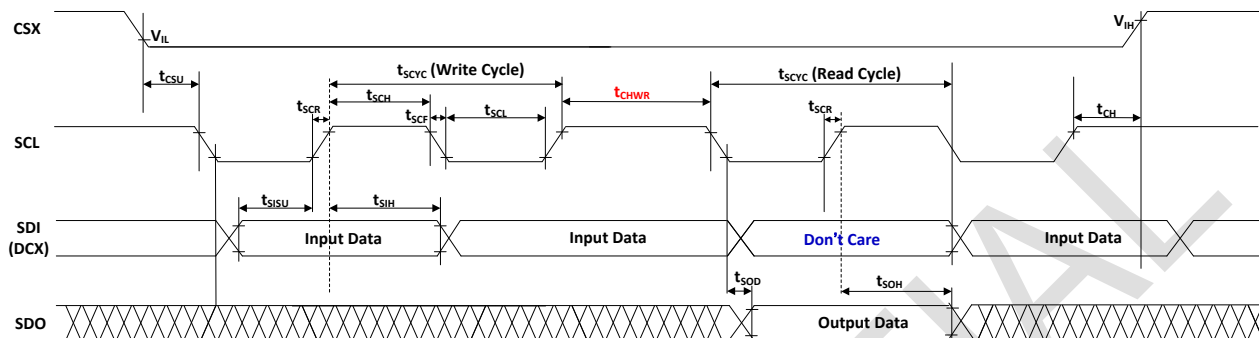
Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Clock cycle	t_{SCYC}	Write	20			ns
		Read	300			ns
Clock high pulse width	t_{SCH}	Write	9			ns
	t_{SCH}	Read	140			ns
Clock low pulse width	t_{SCL}	Write	9			ns
	t_{SCL}	Read	140			ns
Clock rise time	t_{SCR}	0.2*VDDI -> 0.8*VDDI			2	ns
Clock fall time	t_{SCF}	0.8*VDDI -> 0.2*VDDI			2	ns
Chip select setup time	t_{CSU}		10			ns
Chip select hold time	t_{CH}		10			ns
Data input setup time	t_{SISU}	To V_{IL} of SCL's rising edge	5			ns
Data input hold time	t_{SIH}		5			ns
Access time of output data	t_{SOD}	From V_{IL} of SCL's falling edge			120	ns
Hold time of output data	t_{SOH}	From V_{IH} of SCL's rising edge	5			ns
Transition time from Write cycle to Read cycle	t_{CHWR}	From V_{IH} of SCL's rising edge	150			ns

Notes:
(1) Logic high and low levels are specified as 80% and 20% of VDDI for Input signals.
(2) For the 4-wire SPI, the DCX's timing is the same as input data.
(3) Ta = -30°C to 70°C, VDDI=1.65V to 3.3V, VDD=2.7V to 3.6V, and VSS=0V

7.6.2 DSI Timing Characteristics

HS Data Transmission Burst
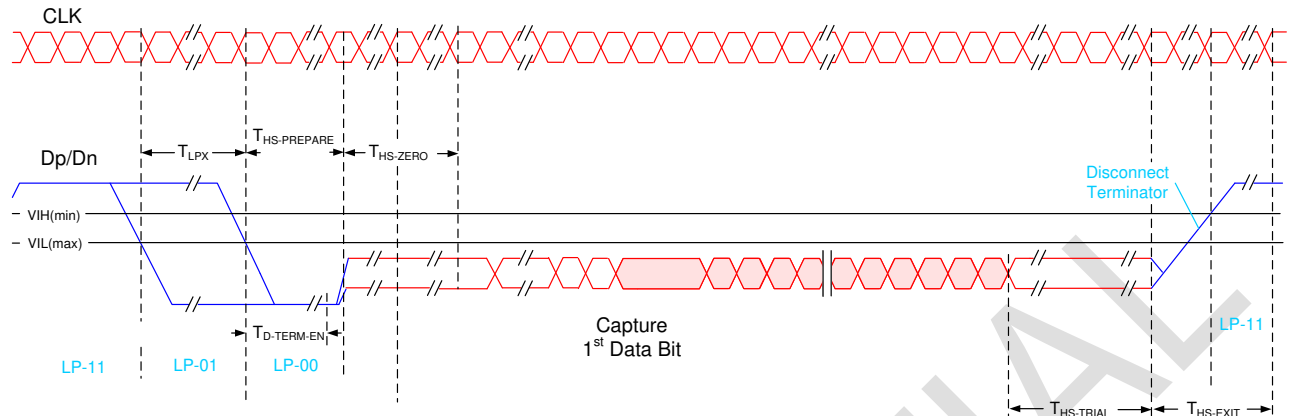
HS clock transmission

Timing Parameters:

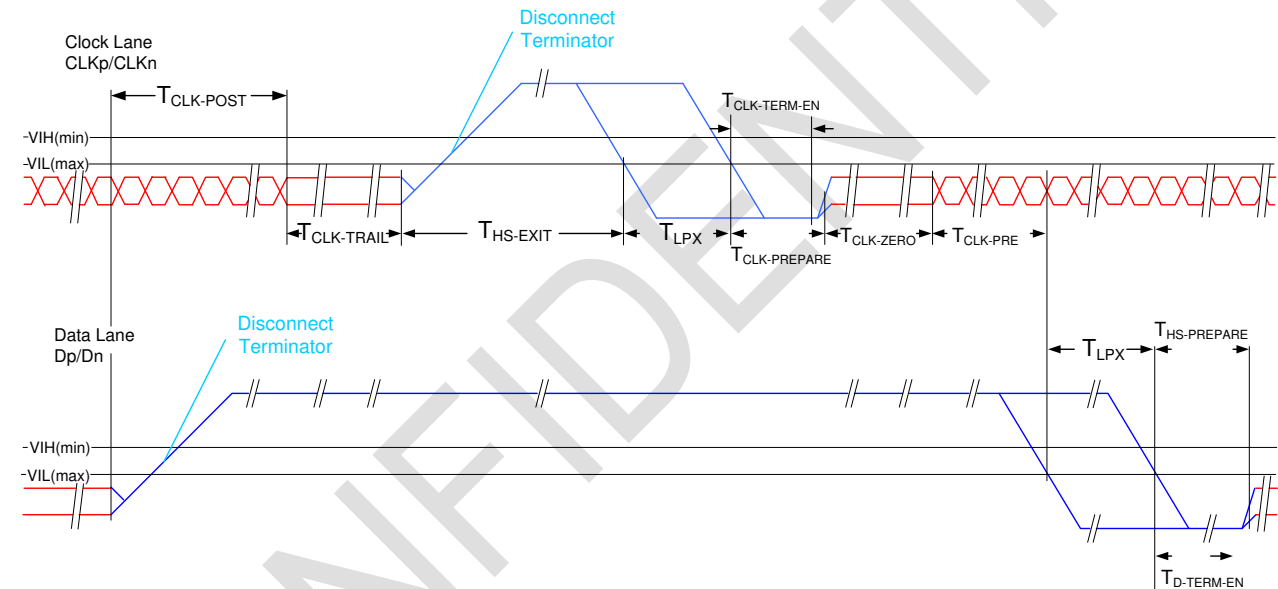| Parameter	Description	Min	Typ	Max	Unit
$T_{CLK-POST}$	Time that the transmitter continues to send HS clock after the last associated Data Lane has transitioned to LP Mode. Interval is defined as the period from the end of $T_{HS-TRAIL}$ to the beginning of $T_{CLK-TRAIL}$.	60ns + 52*UI			ns
$T_{CLK-TRAIL}$	Time that the transmitter drives the HS-0 state after the last payload clock bit of a HS transmission burst.	60			ns
$T_{HS-EXIT}$	Time that the transmitter drives LP-11 following a HS burst.	**300**			ns
$T_{CLK-TERM-EN}$	Time for the Clock Lane receiver to enable the HS line termination, starting from the time point when Dn crosses $V_{IL,MAX}$.	Time for Dn to reach $V_{TERM-EN}$		38	ns
$T_{CLK-PREPARE}$	Time that the transmitter drives the Clock Lane LP-00 Line state immediately before the HS-0 Line state starting the HS transmission.	38		95	ns
$T_{CLK-PRE}$	Time that the HS clock shall be driven by the transmitter prior to any associated Data Lane beginning the transition from LP to HS mode.	8			UI
$T_{CLK-PREPARE}$ + $T_{CLK-ZERO}$	$T_{CLK-PREPARE}$ + time that the transmitter drives the HS-0 state prior to starting the Clock.	300			ns
$T_{D-TERM-EN}$	Time for the Data Lane receiver to enable the HS line termination, starting from the time point when Dn crosses $V_{IL,MAX}$.	Time for Dn to reach $V_{TERM-EN}$		35 ns +4*UI	
$T_{HS-PREPARE}$	Time that the transmitter drives the Data Lane LP-00 Line state immediately before the HS-0 Line state starting the HS transmission	40ns + 4*UI		85 ns + 6*UI	ns
$T_{HS-PREPARE}$ + $T_{HS-ZERO}$	**$T_{HS-PREPARE}$ + time that the transmitter drives the HS-0 state prior to transmitting the Sync sequence.**	**145ns + 10*UI**			**ns**
$T_{HS-TRAIL}$	Time that the transmitter drives the flipped differential state after last payload data bit of a HS transmission burst	60ns + 4*UI			ns

Turnaround Procedure
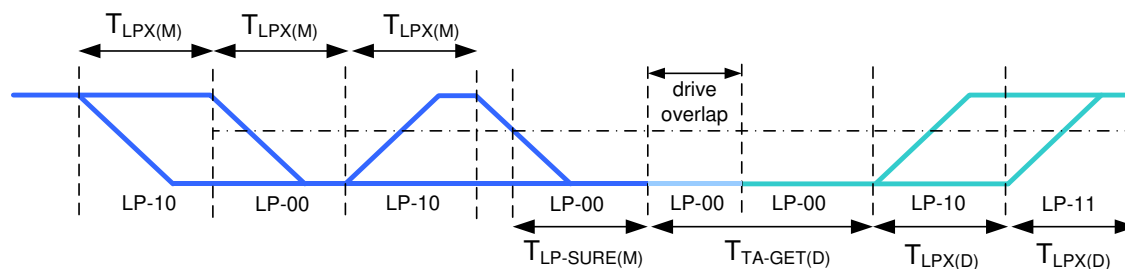
Bus turnaround (BAT) from MPU to display module timing
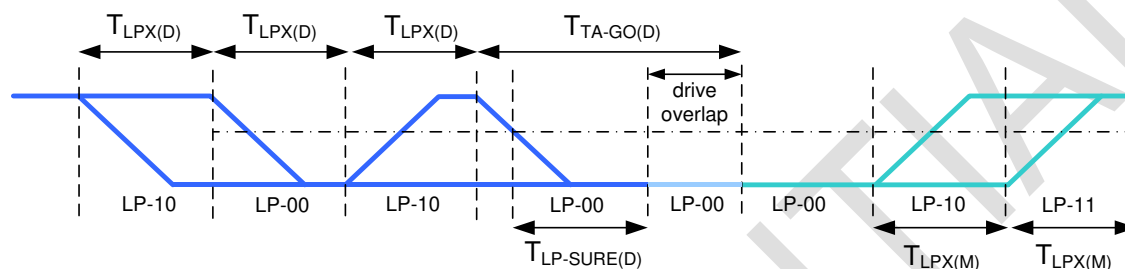
Bus turnaround (BAT) from display module to MPU timing

Low Power Mode :

Parameter	Description	Min	Typ	Max	Unit	Notes
$T_{LPX(M)}$	Transmitted length of any Low-Power state period of MCU to display module	50		**150**	ns	1,2
$T_{TA-SURE(M)}$	Time that the display module waits after the LP-10 state before transmitting the Bridge state (LP-00) during a Link Turnaround.	$T_{LPX(M)}$		$2*T_{LPX(M)}$	ns	2
$T_{LPX(D)}$	Transmitted length of any Low-Power state period of display module to MCU	50		**150**	ns	1,2
$T_{TA-GET(D)}$	Time that the display module drives the Bridge state (LP-00) after accepting control during a Link Turnaround.		$5*T_{LPX(D)}$		ns	2
$T_{TA-GO(D)}$	Time that the display module drives the Bridge state (LP-00) before releasing control during a Link Turnaround.		$4*T_{LPX(D)}$		ns	2
$T_{TA-SURE(D)}$	Time that the MPU waits after the LP-10 state before transmitting the Bridge state (LP-00) during a Link Turnaround.	$T_{LPX(D)}$		$2*T_{LPX(D)}$	ns	2

NOTE:
1. T_{LPX} is an internal state machine timing reference. Externally measured values may differ slightly from the specified values due to asymmetrical rise and fall times.
2. Transmitter-specific parameter

7.6.3 Reset Timing
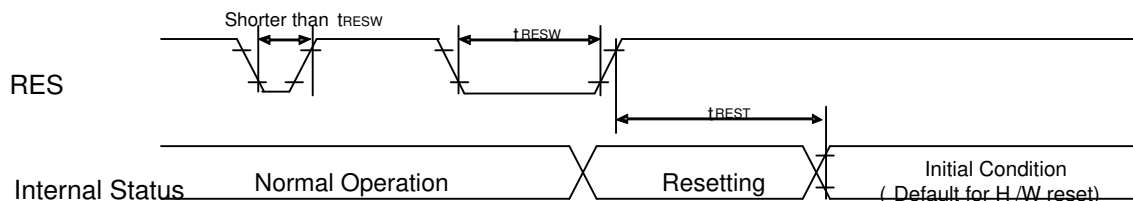
Reset input timing:
VDDI=1.65 to 3.3V, VDD=2.7 to 3.6V, AGND=DGND=0V, Ta=-40 to 85℃

Symbol	Parameter	Related Pins	MIN	TYP	MAX	Note	Unit
t_{RESW}	*1) Reset low pulse width	RESX	10	-	-	-	μs
t_{REST}	*2) Reset complete time	-	-	-	5	When reset applied during Sleep in mode	ms
		-			120	When reset applied during Sleep out mode	ms

Note 1) Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below.

RESX Pulse	Action
Shorter than 5μs	Reset Rejected
Longer than 10μs	Reset
Between 5μs and 10μs	Reset starts (It depends on voltage and temperature condition.)

Note 2. During the resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode) and then return to Default condition for H/W reset.

Note 3. During Reset Complete Time, data in OTP will be latched to internal register during this period. This loading is done every time when there is H/W reset complete time (tREST) within 5ms after a rising edge of RESX.

Note 4. Spike Rejection also applies during a valid reset pulse as shown below:
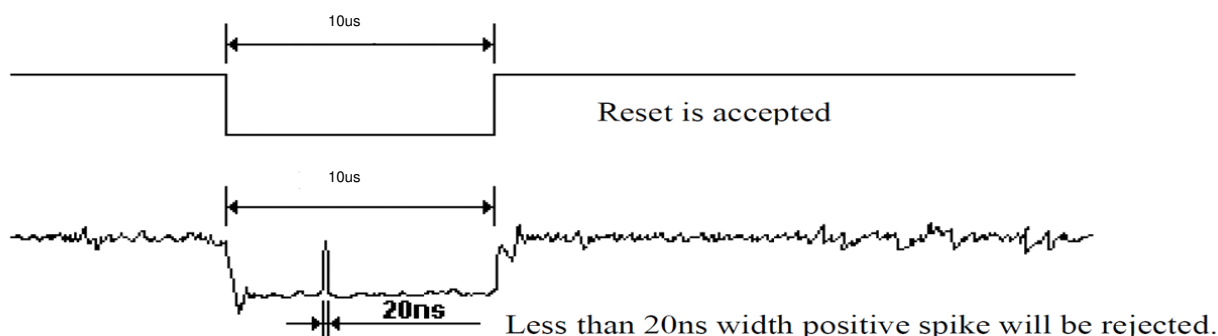
Note 5. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

8. Power Generation

8.1 Two Supply Power (VDDI / VDD)

VGH (AVDD, AVDD+VCI, 2xAVDD)

VGHR (3 ~10.5v)

AVDD (4.5 ~6.5v), (2xVCI, 3xVCI)

VDD = VDDA = VDDB = VDDR (2.7~3.6v)

VGMP (2v ~ 6.3v)   VREFP (0.5 ~ 5V)

VCC (1.65~3.6v)

VGSP (0 ~ 4.5v)

VDDI (1.65~3.3v)   DVDD(1.5v)

VSSA = VSSB = VSSR = VSSI = DVSS = VSSAM (0v)

VREFN (0, -0.5 ~ -4.5v)

VCL (-2.7v, -3.5~ -5v), (-1xVCI, -2xVCI)

VGLR (-2 ~ -15v)

VGL (VCL, VCL-VCI, VCL-AVDD)
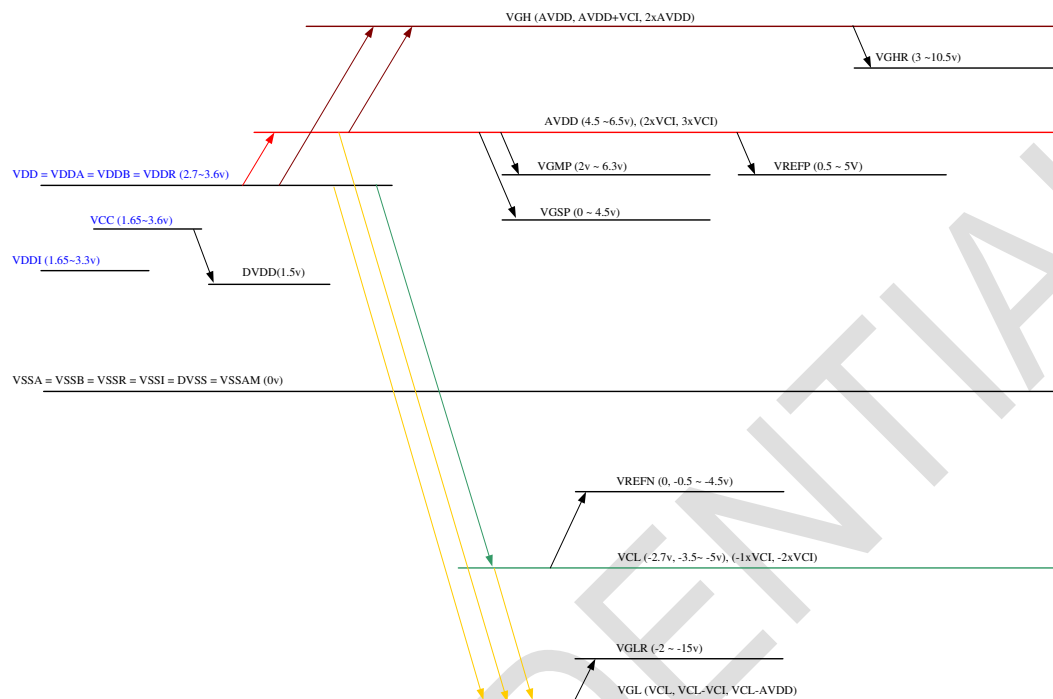
8.2 DC/DC Converter Circuit

2PWR(VDDI, VDD)
VDD=VDDA=VDDR=VDDB
AVDD/VCL → internal CP
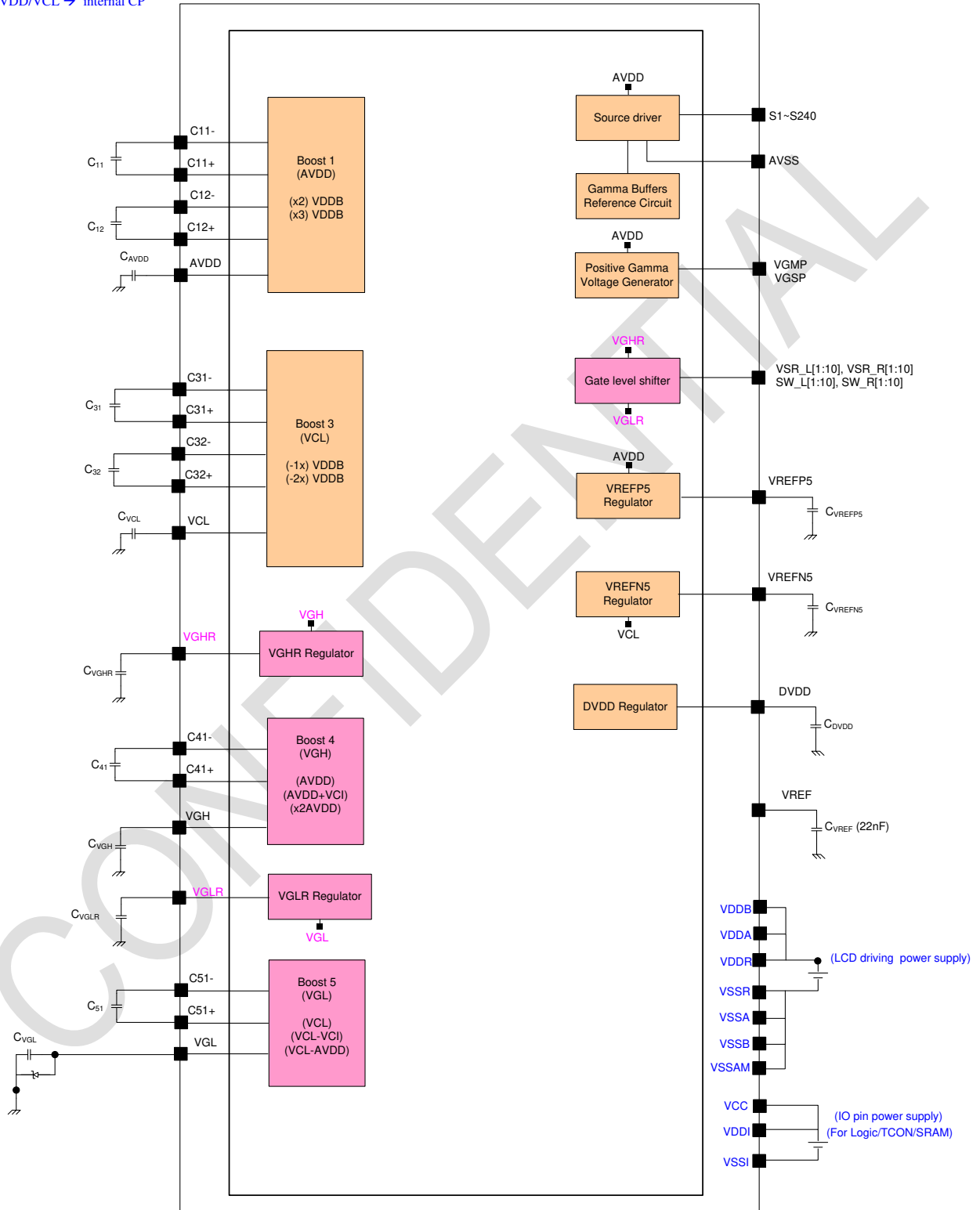
8.3 External Components

No.	Signal name	Values	Max ability
1	VDDA, VDDR, VDDB	Cap , 2.2uF	6.3V
2	VDDI, VCC	Cap , 2.2uF	6.3V
3	VREF	Cap , 22nF	6.3V
4	DVDD	Cap , 1.0uF	6.3V
5	VREFN/VREFP	Cap , 1.0uF	6.3V
6	VGHR	Cap , 2.2uF	16V
7	VGLR	Cap , 2.2uF	16V
8	BVP3D	Cap , 2.2uF	10V
9	BVN3D	Cap , 2.2uF	10V
10	C11P/C11N	Cap , 1.0uF	6.3V
11	C12P/C12N	Cap , 1.0uF	6.3V
12	AVDD	Cap , 2.2uF	10V
13	C31P/C31N	Cap , 1.0uF	6.3V
14	C32P/C32N	Cap , 1.0uF	6.3V
15	VCL	Cap , 2.2uF	6.3V
16	C41P/C41N	Cap , 1.0uF	16V
17	VGH	Cap , 2.2uF	25V
18	C51P/C51N	Cap , 1.0uF	16V
19	VGL	Cap , 2.2uF	25V
20	VGL (VGL-GND)	Schottky Diode	

8.4 Power on/off sequence and timing

Power On sequence

| IC state | Power on | Reset | MIPI initial | Initial setting & sleepout | | Display on |

VDDI — 90% VDDI

VDD — 90% VDD

VBAT

RESX

MIPI I/F — LP11 | initial setting | SLPOUT | Image write | DISPON

>10ms

No order | >10ms | >10ms | T-ini >1ms | >60ms

Power Off sequence

| IC state | Display on | Display off & sleep in | Power down |

VDDI

VDD

VBAT

RESX

MIPI I/F — DISPOFF SLPIN

> 5 frame
>83 ms @ 60hz

>0 | >0 | >10ms
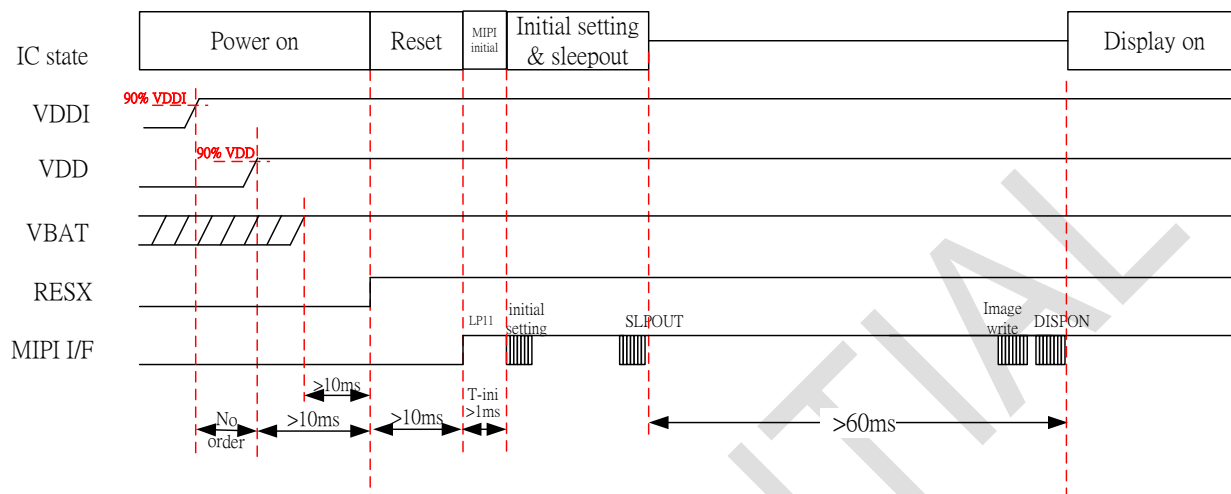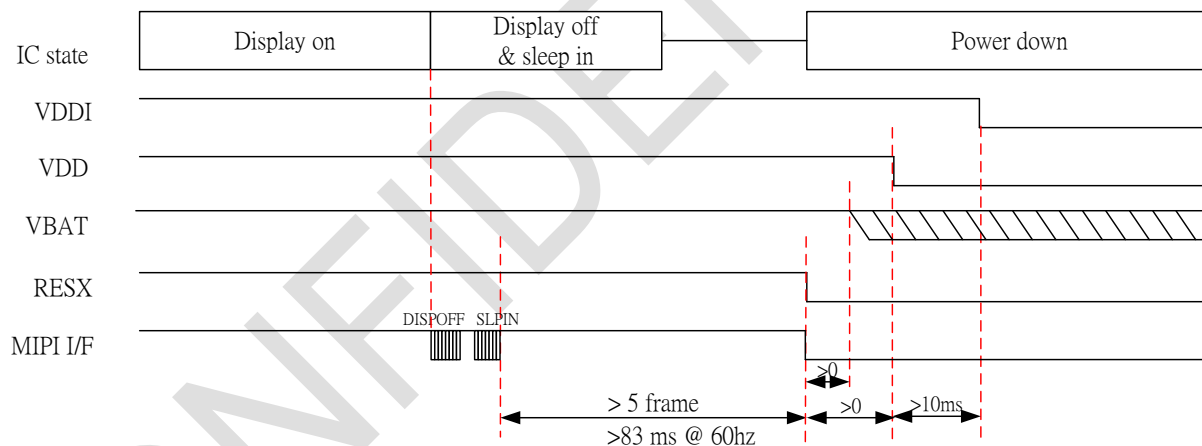
8.5 Power Level Modes

Normal display mode on = NORON
Partial mode on = PTLON
Idle mode off = IDMOFF
Idle mode on = IDMON
Sleep out = SLPOUT
Sleep in = SLPIN
Deep standby mode = DSTBON

Definition example:

1. Normal Mode On (full display), Idle Mode Off, Sleep Out.
In this mode, the display is able to show maximum 16.7M colors.
2. Partial Mode On, Idle Mode Off, Sleep Out
In this mode, part of the display is used with maximum 16.7M colors.
3. Normal Mode On (full display), Idle Mode On, Sleep Out.
In this mode, the full display is used but with 8 colors.
4. Partial Mode On, Idle Mode On, Sleep Out
In this mode, part of the display is used but with 8 colors.
5. Sleep In Mode.
In this mode, the DC/DC converter, internal oscillator and panel driver circuit are stopped. Only the MPU interface and registers are working with VDDI power supply. Contents of the frame memory can be safe or random.
6. Deep Standby Mode.
In this mode, the DC/DC converter, internal oscillator and panel driver circuit are stopped. The MPU interface and registers are not working. Contents of the frame memory are random.
7. Power Off Mode
In this mode, VDDI and VDDA/VDDR/VDDB are removed.

NOTE: Transition between mode 1~5 is controllable by MPU commands. Mode 6 is entered for power saving with both power supplies for I/O and analog circuits and can be exited by hardware reset only (RESX=L). Mode 7 is entered only when both power supplies for I/O and analog circuits are removed.

8.6 Maximum Series Resistance

Pin Name	Type	Max Resistance	Unit
VDDA, VDDB, VDDR, VDDI, VCC,	Power Supply	5	Ω
AVSS, VSSAM, DVSS, VSSI, VSSA, VSSR, VSSB	Power Supply	5	Ω
AVDD	Power Input/Output	5	Ω
DVDD	Power Output	5	Ω
VCL	Power Output	5	Ω
VGH, VGL	Power Output	10	Ω
C11P/N~C12P/N	Capacitor Connection	5	Ω
C31P/N~C32P/N	Capacitor Connection	5	Ω
C41P/N	Capacitor Connection	5	Ω
C51P/N	Capacitor Connection	5	Ω
HSSI_CLK_P/N, HSSI_DATA0_P/N, HSSI_DATA1_P/N,	MIPI Interface I/O	5	Ω
TE, SWIRE, OLED_EN	Digital Output I/O	20	Ω
RESX, CSX, D/CX, SCL, SDI, SDO,D[0]~D[7]	Digital Interface I/O	20	Ω
IM[1 :0], DSWAP, PSWAP	Input I/O	100	Ω
MTP_PWR	Power Supply	5	Ω
S[1]~S[240]	Source output	20	Ω
VSR_L[1]~ VSR_L[10], VSR_R[1]~ VSR_R[10] SW_L[1]~ SW_L[10], SW_R[1]~ SW_R[10]	GOA,SWoutput	20	Ω

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9. Pad Diagram and Coordination

FACE UP (COF)

FACE UP (COG)
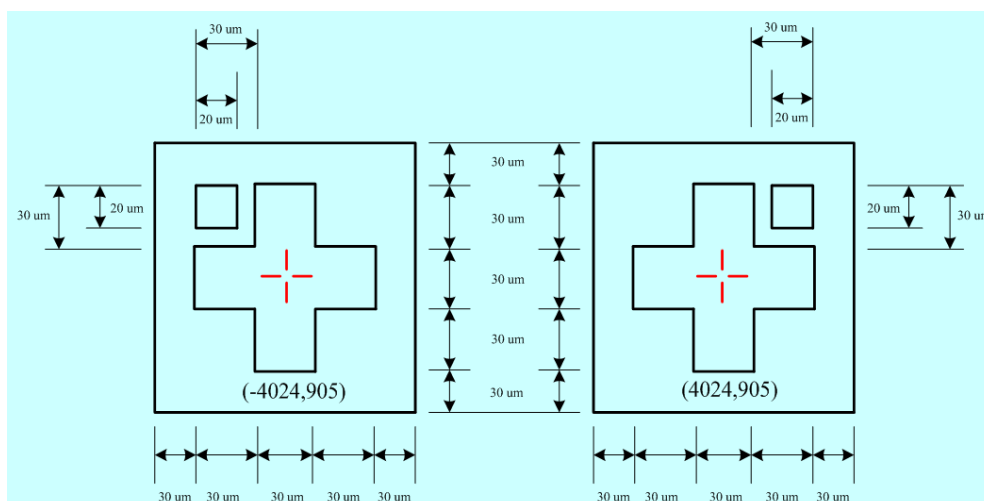
- ◆ Chip size: 8300 um x 2060um (Include sealing and scribe line)
- ◆ Chip thickness: 200/300 um
- ◆ PAD coordinates: PAD center
- ◆ PAD coordinates origin: Chip center
- ◆ Au bump size
  - ❖ COF:
    - ◆ 16um/18um x 35um: Source:S1~S240
    - ◆ 20um x 35um: gate control signal
    - ◆ 25um x 38um: Input Pads
  - ❖ COG:
    - ◆ 17um x 100um: Source:S1~S240
    - ◆ 20um x 100um: gate control signal
    - ◆ 25um x 130um: Input PadsAu bump pitch: See PAD coordinates table
- ◆ Au bump height: 12±2 um (typ.)
- ◆ No. in the figure corresponds to No. in the PAD coordinates table
- ◆ Alignment mark

Alignment mark shape	X	Y
left	4024	905
right	-4024	905

◆ Pad Coordinate (Unit: um)

NO	PAD NAME		NO	PAD NAME		NO	PAD NAME		NO	PAD NAME
1	ANALOG_TEST[1]		51	D[0]		101	VSSR		151	C32N
2	VGLR		52	VSSI		102	VSSR		152	C32N
3	VGLR		53	D[1]		103	VSSA		153	C41P
4	VGHR		54	D[2]		104	VSSA		154	C41P
5	VGHR		55	D[3]		105	VSSA		155	C41N
6	VREFP5		56	D[4]		106	AVSS		156	C41N
7	VREFP5		57	D[5]		107	AVSS		157	C51N
8	VREFP5		58	VSSI		108	AVSS		158	C51N
9	VREFN5		59	D[6]		109	VSSB		159	C51P
10	VREFN5		60	D[7]		110	VSSB		160	C51P
11	VREFN5		61	TEST[1]		111	VSSB		161	VGH
12	BVP3D		62	EXTCLK		112	VSSB		162	VGH
13	BVP3D		63	TEST[2]		113	VSSB		163	VGH
14	BVP3D		64	VSSI		114	C11P		164	VGHR
15	BVN3D		65	TEST[3]		115	C11P		165	VGHR
16	BVN3D		66	IM[1]		116	C11P		166	VGHR
17	BVN3D		67	IM[0]		117	C11N		167	VGLR
18	VCL		68	DSWAP		118	C11N		168	VGLR
19	VCL		69	TESTEN		119	C11N		169	VGLR
20	VCL		70	PSWAP		120	C12P		170	VGL
21	AVDD		71	BSTM		121	C12P		171	VGL
22	AVDD		72	VDDI		122	C12P		172	VGL
23	AVDD		73	VDDI		123	C12N		173	AVSS
24	VREF		74	VDDI		124	C12N		174	AVSS
25	VGSP		75	VCC		125	C12N		175	AVSS
26	VGMP		76	VCC		126	VDDB		176	MTP_PWR
27	ANALOG_TEST[2]		77	VCC		127	VDDB		177	MTP_PWR
28	VDDR		78	DVDD		128	VDDB		178	MTP_PWR
29	VDDR		79	DVDD		129	VDDB		179	MTP_PWR
30	VDDR		80	DVDD		130	VDDB		180	MTP_PWR
31	VDDA		81	DVDD		131	VDDR		181	MTP_PWR
32	VDDA		82	DVSS		132	VDDR		182	DUMMY
33	VDDA		83	DVSS		133	VDDR		183	VGLR
34	AVSS		84	DVSS		134	VDDR		184	VGLR
35	AVSS		85	DVSS		135	AVDD		185	VGHR
36	AVSS		86	HSSI_D1_P		136	AVDD		186	VGHR
37	VSSR		87	HSSI_D1_P		137	AVDD		187	VREFP5
38	VSSR		88	HSSI_D1_N		138	C31P		188	VREFP5
39	VSSR		89	HSSI_D1_N		139	C31P		189	VREFN5
40	TE1		90	VSSAM		140	C31P		190	VREFN5
41	SWIRE		91	HSSI_CLK_P		141	C31N		191	VSR_L[10]
42	OLED_EN		92	HSSI_CLK_P		142	C31N		192	VSR_L[10]
43	TE		93	HSSI_CLK_N		143	C31N		193	VSR_L[9]
44	RESX		94	HSSI_CLK_N		144	VCL		194	VSR_L[9]
45	SDO		95	VSSAM		145	VCL		195	VSR_L[8]
46	VSSI		96	HSSI_D0_P		146	VCL		196	VSR_L[8]
47	SDI_RDX		97	HSSI_D0_P		147	C32P		197	VSR_L[7]
48	DCX		98	HSSI_D0_N		148	C32P		198	VSR_L[7]
49	WRX_SCL		99	HSSI_D0_N		149	C32P		199	VSR_L[6]
50	CSX		100	VSSR		150	C32N		200	VSR_L[6]

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#	Signal	#	Signal	#	Signal	#	Signal
201	VSR_L[5]	251	S[221]	301	S[171]	351	S[121]
202	VSR_L[5]	252	S[220]	302	S[170]	352	VGHR
203	VSR_L[4]	253	S[219]	303	S[169]	353	VGLR
204	VSR_L[4]	254	S[218]	304	S[168]	354	VREFN5
205	VSR_L[3]	255	S[217]	305	S[167]	355	SDMY[1]
206	VSR_L[3]	256	S[216]	306	S[166]	356	SDMY[2]
207	VSR_L[2]	257	S[215]	307	S[165]	357	SDMY[3]
208	VSR_L[2]	258	S[214]	308	S[164]	358	SDMY[4]
209	VSR_L[1]	259	S[213]	309	S[163]	359	SDMY[5]
210	VSR_L[1]	260	S[212]	310	S[162]	360	SDMY[6]
211	SW_L[1]	261	S[211]	311	S[161]	361	SDMY[7]
212	SW_L[1]	262	S[210]	312	S[160]	362	SDMY[8]
213	SW_L[2]	263	S[209]	313	S[159]	363	SDMY[9]
214	SW_L[2]	264	S[208]	314	S[158]	364	SDMY[10]
215	SW_L[3]	265	S[207]	315	S[157]	365	SDMY[11]
216	SW_L[3]	266	S[206]	316	S[156]	366	SDMY[12]
217	SW_L[4]	267	S[205]	317	S[155]	367	SDMY[13]
218	SW_L[4]	268	S[204]	318	S[154]	368	SDMY[14]
219	SW_L[5]	269	S[203]	319	S[153]	369	SDMY[15]
220	SW_L[5]	270	S[202]	320	S[152]	370	SDMY[16]
221	SW_L[6]	271	S[201]	321	S[151]	371	SDMY[17]
222	SW_L[6]	272	S[200]	322	S[150]	372	SDMY[18]
223	SW_L[7]	273	S[199]	323	S[149]	373	SDMY[19]
224	SW_L[7]	274	S[198]	324	S[148]	374	SDMY[20]
225	SW_L[8]	275	S[197]	325	S[147]	375	VREFP5
226	SW_L[8]	276	S[196]	326	S[146]	376	VGLR
227	SW_L[9]	277	S[195]	327	S[145]	377	VGHR
228	SW_L[9]	278	S[194]	328	S[144]	378	S[120]
229	SW_L[10]	279	S[193]	329	S[143]	379	S[119]
230	SW_L[10]	280	S[192]	330	S[142]	380	S[118]
231	SDMY[21]	281	S[191]	331	S[141]	381	S[117]
232	S[240]	282	S[190]	332	S[140]	382	S[116]
233	S[239]	283	S[189]	333	S[139]	383	S[115]
234	S[238]	284	S[188]	334	S[138]	384	S[114]
235	S[237]	285	S[187]	335	S[137]	385	S[113]
236	S[236]	286	S[186]	336	S[136]	386	S[112]
237	S[235]	287	S[185]	337	S[135]	387	S[111]
238	S[234]	288	S[184]	338	S[134]	388	S[110]
239	S[233]	289	S[183]	339	S[133]	389	S[109]
240	S[232]	290	S[182]	340	S[132]	390	S[108]
241	S[231]	291	S[181]	341	S[131]	391	S[107]
242	S[230]	292	S[180]	342	S[130]	392	S[106]
243	S[229]	293	S[179]	343	S[129]	393	S[105]
244	S[228]	294	S[178]	344	S[128]	394	S[104]
245	S[227]	295	S[177]	345	S[127]	395	S[103]
246	S[226]	296	S[176]	346	S[126]	396	S[102]
247	S[225]	297	S[175]	347	S[125]	397	S[101]
248	S[224]	298	S[174]	348	S[124]	398	S[100]
249	S[223]	299	S[173]	349	S[123]	399	S[99]
250	S[222]	300	S[172]	350	S[122]	400	S[98]

401	S[97]	451	S[47]	501	SW_R[9]
402	S[96]	452	S[46]	502	SW_R[8]
403	S[95]	453	S[45]	503	SW_R[8]
404	S[94]	454	S[44]	504	SW_R[7]
405	S[93]	455	S[43]	505	SW_R[7]
406	S[92]	456	S[42]	506	SW_R[6]
407	S[91]	457	S[41]	507	SW_R[6]
408	S[90]	458	S[40]	508	SW_R[5]
409	S[89]	459	S[39]	509	SW_R[5]
410	S[88]	460	S[38]	510	SW_R[4]
411	S[87]	461	S[37]	511	SW_R[4]
412	S[86]	462	S[36]	512	SW_R[3]
413	S[85]	463	S[35]	513	SW_R[3]
414	S[84]	464	S[34]	514	SW_R[2]
415	S[83]	465	S[33]	515	SW_R[2]
416	S[82]	466	S[32]	516	SW_R[1]
417	S[81]	467	S[31]	517	SW_R[1]
418	S[80]	468	S[30]	518	VSR_R[1]
419	S[79]	469	S[29]	519	VSR_R[1]
420	S[78]	470	S[28]	520	VSR_R[2]
421	S[77]	471	S[27]	521	VSR_R[2]
422	S[76]	472	S[26]	522	VSR_R[3]
423	S[75]	473	S[25]	523	VSR_R[3]
424	S[74]	474	S[24]	524	VSR_R[4]
425	S[73]	475	S[23]	525	VSR_R[4]
426	S[72]	476	S[22]	526	VSR_R[5]
427	S[71]	477	S[21]	527	VSR_R[5]
428	S[70]	478	S[20]	528	VSR_R[6]
429	S[69]	479	S[19]	529	VSR_R[6]
430	S[68]	480	S[18]	530	VSR_R[7]
431	S[67]	481	S[17]	531	VSR_R[7]
432	S[66]	482	S[16]	532	VSR_R[8]
433	S[65]	483	S[15]	533	VSR_R[8]
434	S[64]	484	S[14]	534	VSR_R[9]
435	S[63]	485	S[13]	535	VSR_R[9]
436	S[62]	486	S[12]	536	VSR_R[10]
437	S[61]	487	S[11]	537	VSR_R[10]
438	S[60]	488	S[10]	538	VREFN5
439	S[59]	489	S[9]	539	VREFN5
440	S[58]	490	S[8]	540	VREFP5
441	S[57]	491	S[7]	541	VREFP5
442	S[56]	492	S[6]	542	VGHR
443	S[55]	493	S[5]	543	VGHR
444	S[54]	494	S[4]	544	VGLR
445	S[53]	495	S[3]	545	VGLR
446	S[52]	496	S[2]		
447	S[51]	497	S[1]		
448	S[50]	498	SW_R[10]		
449	S[49]	499	SW_R[10]		
450	S[48]	500	SW_R[9]		